

## **Stacking TPS546D24A Two-Phase Evaluation Module**

The TPS546D24AEVM-2PH evaluation module (EVM) is a two-phase buck converter with two TPS546D24A devices. The TPS546D24A device is a stackable synchronous buck with PMBus interface that can operate from a nominal 2.95-V to 16-V supply. The device allows programming and monitoring via the PMBus interface.

Two TPS546D24A devices are configured as two-phase buck converter in factory default, output current is evenly distributed in the two devices; both the negative and positive output terminals are connected together.

### **Contents**

|      |                                                                     |    |
|------|---------------------------------------------------------------------|----|
| 1    | Description .....                                                   | 3  |
| 1.1  | Before You Begin .....                                              | 3  |
| 1.2  | Typical Applications .....                                          | 4  |
| 1.3  | Features .....                                                      | 4  |
| 2    | Electrical Performance Specifications .....                         | 5  |
| 3    | Schematic .....                                                     | 6  |
| 4    | Test Setup .....                                                    | 9  |
| 4.1  | Test and Configuration Software .....                               | 9  |
| 4.2  | Test Equipment .....                                                | 9  |
| 4.3  | Tip and Barrel Measurement .....                                    | 10 |
| 4.4  | List of Test Points, Jumpers, and Connectors .....                  | 10 |
| 4.5  | Evaluating Single Phase Operation .....                             | 13 |
| 4.6  | Evaluating Split Rail Input .....                                   | 13 |
| 4.7  | Configuring EVM to Overdrive VDD5 .....                             | 13 |
| 5    | EVM Configuration Using the Fusion GUI .....                        | 14 |
| 5.1  | Configuration Procedure .....                                       | 14 |
| 6    | Test Procedure .....                                                | 15 |
| 6.1  | Line and Load Regulation and Efficiency Measurement Procedure ..... | 15 |
| 6.2  | Efficiency Measurement Test Points .....                            | 16 |
| 6.3  | Control Loop Gain and Phase Measurement Procedure .....             | 17 |
| 7    | Performance Data and Typical Characteristic Curves .....            | 18 |
| 7.1  | Efficiency .....                                                    | 18 |
| 7.2  | Load and Line Regulation (Measured Between TP22 and TP25) .....     | 18 |
| 7.3  | Transient Response .....                                            | 19 |
| 7.4  | Control Loop Bode Plot .....                                        | 19 |
| 7.5  | Output Ripple .....                                                 | 20 |
| 7.6  | Power MOSFET Drain-Source Voltage .....                             | 21 |
| 7.7  | Control On .....                                                    | 22 |
| 7.8  | Control Off .....                                                   | 23 |
| 7.9  | Control On With Pre-biased Output .....                             | 24 |
| 7.10 | Current Sharing Between Two Phases .....                            | 24 |
| 7.11 | Thermal Image .....                                                 | 25 |
| 8    | EVM Assembly Drawing and PCB Layout .....                           | 26 |
| 9    | Bill of Materials .....                                             | 29 |
| 10   | Using the Fusion GUI .....                                          | 32 |
| 10.1 | Opening the Fusion GUI .....                                        | 32 |
| 10.2 | General Settings .....                                              | 33 |
| 10.3 | Changing ON_OFF_CONFIG .....                                        | 34 |

|       |                                                            |    |
|-------|------------------------------------------------------------|----|
| 10.4  | Pop-up for Some Commands While Conversion is Enabled ..... | 35 |
| 10.5  | SMBALERT# Mask .....                                       | 36 |
| 10.6  | Device Info .....                                          | 37 |
| 10.7  | Phase Commands.....                                        | 38 |
| 10.8  | All Config .....                                           | 39 |
| 10.9  | Pin Strapping.....                                         | 40 |
| 10.10 | Monitor .....                                              | 41 |
| 10.11 | Status.....                                                | 42 |

### List of Figures

|    |                                                                             |    |
|----|-----------------------------------------------------------------------------|----|
| 1  | TPS546D24AEVM-2PH Schematic Page 1 .....                                    | 6  |
| 2  | TPS546D24AEVM-2PH Schematic Page 2 (U1_P1 Master) .....                     | 7  |
| 3  | TPS546D24AEVM-2PH Schematic Page 3 (U1_P2 Slave) .....                      | 8  |
| 4  | Tip and Barrel Measurement .....                                            | 10 |
| 5  | Efficiency, $V_{OUT}$ Measured Using TP13, TP16, TP26 and TP30 .....        | 18 |
| 6  | Efficiency, $V_{OUT}$ Measured Using TP22 and TP25 .....                    | 18 |
| 7  | Load Regulation .....                                                       | 18 |
| 8  | Line Regulation.....                                                        | 18 |
| 9  | Transient Response .....                                                    | 19 |
| 10 | Bode Plot at 0.8-V Output at 12 $V_{IN}$ , 20-A Load.....                   | 19 |
| 11 | Output Ripple With 0-A Load .....                                           | 20 |
| 12 | Output Ripple With 80-A Load .....                                          | 20 |
| 13 | Low-side MOSFET $V_{DS}$ .....                                              | 21 |
| 14 | High-side MOSFET $V_{DS}$ .....                                             | 21 |
| 15 | Start-Up From Control, 0-A Load .....                                       | 22 |
| 16 | Start-Up From Control, 80-A CC Load .....                                   | 22 |
| 17 | Shutdown From Control, 0-A Load.....                                        | 23 |
| 18 | Shutdown From Control, 20-A CC Load .....                                   | 23 |
| 19 | Start-Up From Control With Pre-biased Output .....                          | 24 |
| 20 | Inductor Current and Switch Node Waveform, 40-A Load.....                   | 24 |
| 21 | Thermal Image .....                                                         | 25 |
| 22 | TPS546D24AEVM-2PH Top Side Component View (Top View) .....                  | 26 |
| 23 | TPS546D24AEVM-2PH Bottom Side Component View (Bottom View) .....            | 26 |
| 24 | TPS546D24AEVM-2PH Top Copper (Top View) .....                               | 26 |
| 25 | TPS546D24AEVM-2PH Internal Layer 1 (Top View).....                          | 26 |
| 26 | TPS546D24AEVM-2PH Internal Layer 2 (Top View).....                          | 26 |
| 27 | TPS546D24AEVM-2PH Internal Layer 3 (Top View).....                          | 26 |
| 28 | TPS546D24AEVM-2PH Internal Layer 4 (Top View).....                          | 27 |
| 29 | TPS546D24AEVM-2PH Internal Layer 5 (Top View).....                          | 27 |
| 30 | TPS546D24AEVM-2PH Internal Layer 6 (Top View).....                          | 27 |
| 31 | TPS546D24AEVM-2PH Internal Bottom Layer (Top View).....                     | 27 |
| 32 | Select Device Scanning Mode.....                                            | 32 |
| 33 | General Settings.....                                                       | 33 |
| 34 | Configure – ON_OFF_CONFIG .....                                             | 34 |
| 35 | Pop-up When Trying to Change FREQUENCY_SWITCH With Conversion Enabled ..... | 35 |
| 36 | Configure – SMBALERT # Mask.....                                            | 36 |
| 37 | Configure – Device Info .....                                               | 37 |
| 38 | Phase Commands .....                                                        | 38 |
| 39 | Configure – All Config .....                                                | 39 |
| 40 | Configure – Pin Strapping.....                                              | 40 |

|    |                      |    |
|----|----------------------|----|
| 41 | Monitor Screen ..... | 41 |
| 42 | Status Screen.....   | 42 |

### List of Tables

|    |                                                               |    |
|----|---------------------------------------------------------------|----|
| 1  | TPS546D24AEVM-2PH Electrical Performance Specifications ..... | 5  |
| 2  | Test Point Functions .....                                    | 10 |
| 3  | Jumpers .....                                                 | 11 |
| 4  | JP2_P1 and JP2_P2 Selections .....                            | 11 |
| 5  | JP7_P1 and JP7_P2 Selections .....                            | 11 |
| 6  | Connector Functions.....                                      | 12 |
| 7  | Test Points for Efficiency Measurements .....                 | 16 |
| 8  | Test Points for Better Efficiency Measurements .....          | 16 |
| 9  | List of Test Points for Loop Response Measurements.....       | 17 |
| 10 | TPS546D24AEVM-2PH Bill of Materials .....                     | 29 |

## Trademarks

PMBus is a registered trademark of others.

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## 1 Description

The TPS546D24AEVM-2PH is a two-phase buck design using two stacked TPS546D24A devices. It designed for a nominal 12-V bus and to produce a regulated 0.8-V output at up to 80 A of load current. The TPS546D24AEVM-2PH is designed to demonstrate stacking operation of the TPS546D24A in a two-phase, low-output voltage application while providing a number of test points to evaluate the performance of the devices. The TPS546D24AEVM-2PH can be modified to single-phase buck converters by changing the components assembled. See [Section 4.3](#) for more information on single-phase configuration.

### 1.1 Before You Begin

The following warnings and cautions are noted for the safety of anyone using or working close to the TPS546D24AEVM-2PH. Observe all safety precautions.



#### Warning

The TPS546D24AEVM-2PH circuit module may become hot during operation due to dissipation of heat. Avoid contact with the board. Follow all applicable safety procedures applicable to your laboratory.



#### Caution

Do not leave the EVM powered when unattended.

### **WARNING**

The circuit module has signal traces, components, and component leads on the bottom of the board. This may result in exposed voltages, hot surfaces, or sharp edges. Do not reach under the board during operation.

**CAUTION**

The circuit module may be damaged by over temperature. To avoid damage, monitor the temperature during evaluation and provide cooling, as needed, for your system environment.

**CAUTION**

Some power supplies can be damaged by application of external voltages. If using more than 1 power supply, check your equipment requirements and use blocking diodes or other isolation techniques, as needed, to prevent damage to your equipment.

**CAUTION**

The communication interface is not isolated on the EVM. Be sure no ground potential exists between the computer and the EVM. Also be aware that the computer is referenced to the battery- potential of the EVM.

## 1.2 Typical Applications

The TPS546D24A device is designed for the following applications:

- High-density power solutions
- Wireless infrastructure
- Switcher
- Router network
- Server
- Storage
- Smart power systems

## 1.3 Features

This EVM has the following features:

- Regulated 0.8-V output up to 80-A<sub>DC</sub> steady-state output current
- The output voltage is marginable and trimmable using the PMBus interface
  - Programmable UVLO, soft-start, and enable via the PMBus interface
  - Programmable overcurrent warning and fault limits and programmable response to faults via the PMBus interface
  - Programmable overvoltage and undervoltage warning and fault limits and programmable response to faults via the PMBus interface
  - Programmable turn-on and turn-off delays
- Convenient test points for probing critical waveforms

## 2 Electrical Performance Specifications

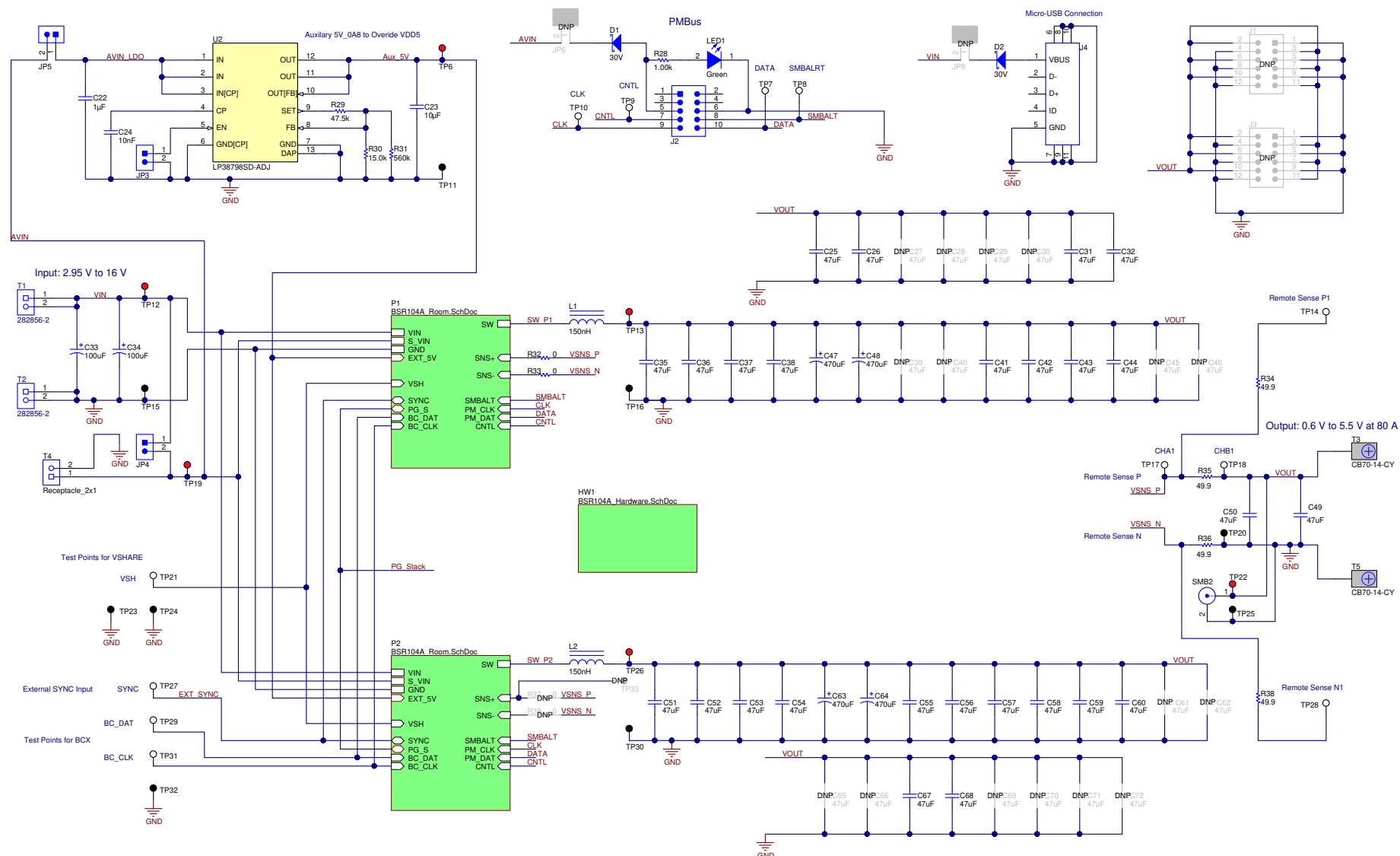
[Table 1](#) lists the electrical performance specifications in room temperature (20 to 25°C). Characteristics are given for an input voltage of  $V_{IN} = 12\text{ V}$ , unless otherwise specified.

**Table 1. TPS546D24AEVM-2PH Electrical Performance Specifications**

| Parameter                                             | Test Conditions                                                         | MIN | TYP   | MAX | Unit    |
|-------------------------------------------------------|-------------------------------------------------------------------------|-----|-------|-----|---------|
| Input Characteristics                                 |                                                                         |     |       |     |         |
| Input voltage range, V <sub>IN</sub>                  |                                                                         | 5   | 12    | 16  | V       |
| Full load input current                               | I <sub>OUT</sub> = 80 A                                                 |     | 6.4   |     | A       |
| Full load input current                               | V <sub>IN</sub> = 5 V, I <sub>OUT</sub> = 80 A                          |     | 15.6  |     | A       |
| No load input current                                 | I <sub>OUT</sub> = 0 A, switching enabled                               |     | 130   |     | mA      |
| Enable switching threshold                            | Set by default resistor divider, JP2_P1 and JP2_P2 pins 3 and 4 shorted |     | 5.26  |     | V       |
| Disable switching threshold                           | Set by default resistor divider, JP2_P1 and JP2_P2 pins 3 and 4 shorted |     | 4.75  |     | V       |
| Output Characteristics                                |                                                                         |     |       |     |         |
| Output voltage, V <sub>OUT</sub>                      |                                                                         |     | 0.8   |     | V       |
| Output load current, I <sub>OUT</sub>                 |                                                                         | 0   |       | 80  | A       |
| Output voltage regulation                             | Line Regulation: V <sub>IN</sub> = 5 V to 16 V                          |     | 0.1%  |     |         |
|                                                       | Load Regulation: I <sub>OUT</sub> = 0 A to 80 A                         |     | 0.1%  |     |         |
| Output voltage ripple                                 | I <sub>OUT</sub> = 80 A                                                 |     | 5     |     | mVpp    |
| Output voltage undershoot                             | I <sub>OUT</sub> = 20-A to 60-A step at 1 A/μs                          |     | 70    |     | mV      |
| Output voltage overshoot                              | I <sub>OUT</sub> = 60-A to 20-A step at 100 A/μs                        |     | 70    |     | mV      |
| Output overcurrent fault threshold                    | Phase current limit setting of U1_P1 programmed by MSEL2                |     | 52    |     | A       |
|                                                       | Phase current limit setting of U1_P2 programmed by MSEL2                |     | 52    |     | A       |
| Systems Characteristics                               |                                                                         |     |       |     |         |
| Switching frequency                                   | Programmed by MSEL1                                                     |     | 550   |     | kHz     |
| Full load efficiency, V <sub>OUT</sub> <sup>(1)</sup> | I <sub>OUT</sub> = 80 A                                                 |     | 84.8% |     |         |
| Operating case temperature                            | I <sub>OUT</sub> = 80 A, 10 minute soak                                 |     | 80    |     | °C      |
| Loop bandwidth                                        | I <sub>OUT</sub> = 40 A                                                 |     | 30.3  |     | kHz     |
| Phase margin                                          |                                                                         |     | 93.5  |     | °       |
| PMBus Interface and Pin-Strapping                     |                                                                         |     |       |     |         |
| U1_P1 PMBus address                                   | Programmed by NVM and ADRSEL                                            |     | 36    |     | Decimal |
| U1_P1 Voltage reference                               | Default setting of VOUT_COMMAND programmed by VSEL                      |     | 800   |     | mV      |
| U1_P1 Soft-start time (TON_RISE)                      | Default setting of TON_RISE programmed by MSEL2                         |     | 3     |     | ms      |

<sup>(1)</sup> The efficiency is measured using the test points listed in [Table 8](#) to minimize the effect of DC drops caused by onboard copper traces.

Figure 1 through Figure 3 illustrate the TPS546D24AEVM-2PH schematics.



**Figure 1. TPS546D24AEVM-2PH Schematic Page 1**

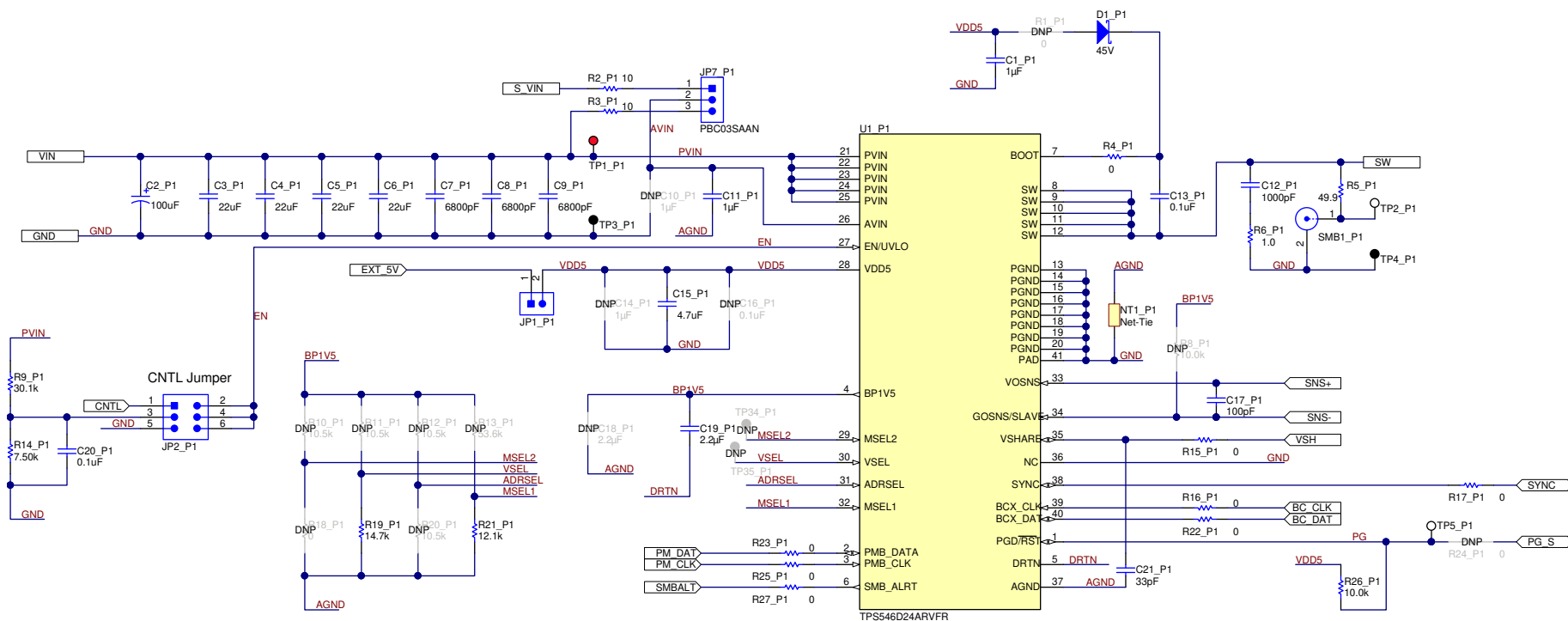


Figure 2. TPS546D24AEVM-2PH Schematic Page 2 (U1\_P1 Master)

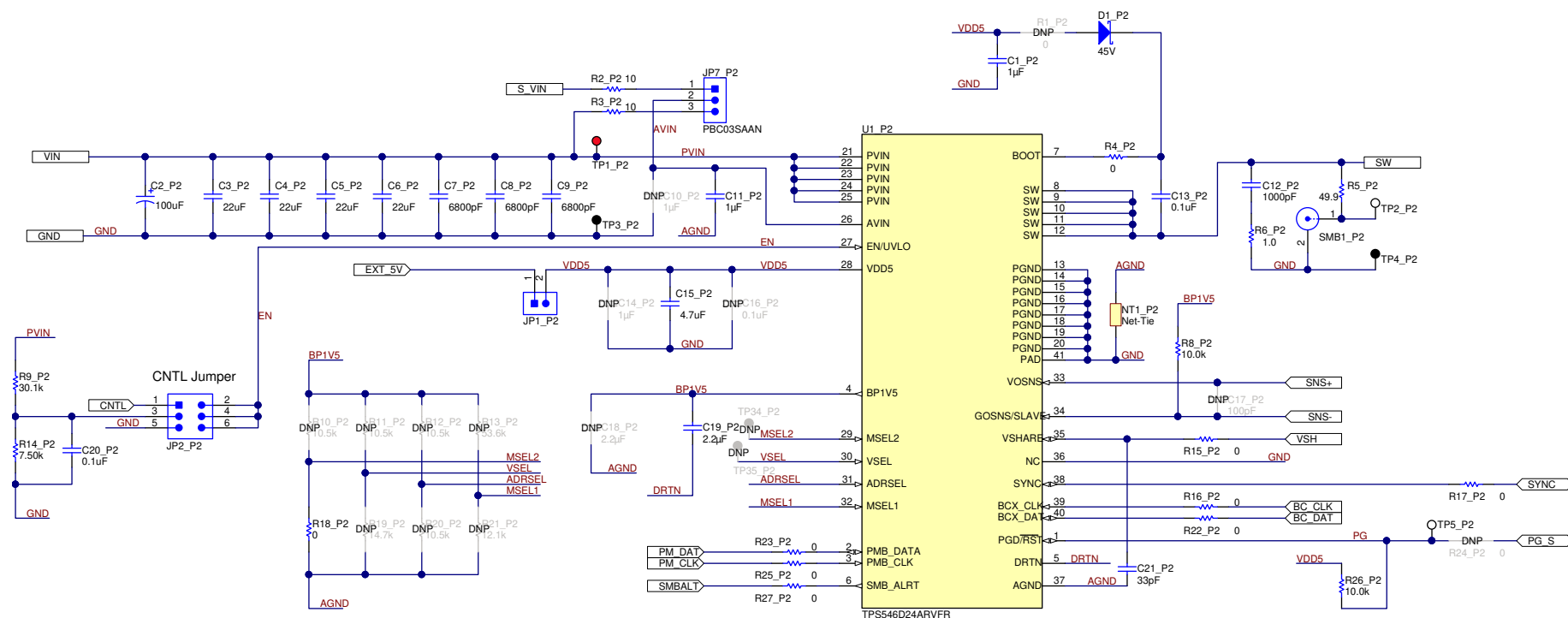


Figure 3. TPS546D24AEVM-2PH Schematic Page 3 (U1\_P2 Slave)

## 4 Test Setup

### 4.1 Test and Configuration Software

To change any of the default configuration parameters on the EVM through PMBus, obtain the [TI Fusion Digital Power Designer](#) software.

#### 4.1.1 Description

The *TI Fusion Digital Power Designer* is the graphical user interface (GUI) used to configure and monitor the Texas Instruments TPS546D24A power converter installed on this evaluation module. The application uses the PMBus protocol to communicate with the controller over serial bus by way of a TI USB adapter described in [Section 4.2.6](#).

#### 4.1.2 Features

Some of the tasks you can perform with the GUI include:

- Turn on or off the power supply output, either through the hardware control line or the PMBus operation command.
- Monitor real-time data. Items such as input voltage, output voltage, output current, die temperature, and warnings and faults that are continuously monitored and displayed by the GUI.
- Configure common operating characteristics such as  $V_{OUT}$  trim and margin, UVLO, soft-start time, warning and fault thresholds, fault response, and On/Off modes.

## 4.2 Test Equipment

### 4.2.1 Voltage Source

The input voltage source  $V_{IN}$  should be a 0-V to 20-V variable DC source capable of supplying a minimum of 16 A to support 80-A load with 5-V input. Connect input VIN and GND to T1 and T2. If the output voltage of the EVM is increased, the power supply may need to be capable of supplying more current.

### 4.2.2 Multimeters

TI recommends using two separate multimeters: one meter to measure  $V_{IN}$  and the other to measure  $V_{OUT}$ .

### 4.2.3 Output Load:

A variable electronic load is recommended for the test setup. To test the full load current this EVM supports, the load should be capable of sinking at least 80 A.

### 4.2.4 Oscilloscope

When using an oscilloscope to measure the switching node voltage or voltage ripple, measure using a *Tip-and-Barrel* method as [Figure 4](#) shows, or better.

### 4.2.5 Fan:

During prolonged operation at high loads, it may be necessary to provide forced air cooling with a small fan aimed at the EVM. Maintain the surface temperature of the devices on the EVM below their rated temperature.

### 4.2.6 USB-to-GPIO Interface Adapter:

A communications adapter is required between the EVM and the host computer. This EVM is designed to use TI's USB-to-GPIO Adapter. Purchase this adapter at <http://www.ti.com/tool/usb-to-gpio>.

### 4.2.7 Recommended Wire Gauge

- Input VIN and GND to T1 and T2 (GND) (12-V input) – The recommended wire size is AWG #12, with

the total length of wire less than 2 feet (1 foot input, 1 foot return).

- Output T3 and GND T5 (0.8-V output) – The minimum recommended wire size is AWG #10, with the total length of wire less than 2 feet (1 foot output, 1 foot return). A thicker wire gauge may be required to minimize the voltage drop the wires.

### 4.3 Tip and Barrel Measurement

Figure 4 illustrates the tip and barrel measurement for switching node waveform on TP2\_P1 with TP4\_P1 or TP2\_P2 with TP4\_P2.

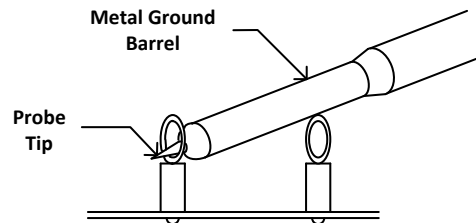


Figure 4. Tip and Barrel Measurement

### 4.4 List of Test Points, Jumpers, and Connectors

Table 2 lists the test point functions.

Table 2. Test Point Functions

| Test Point | Type     | Name        | Description                                                                  |
|------------|----------|-------------|------------------------------------------------------------------------------|
| TP1_P1     | T-H Loop | PVIN_P1     | PVIN pin voltage of U1_P1 device measurement point                           |
| TP1_P2     | T-H Loop | PVIN_P2     | PVIN pin voltage of U1_P2 device measurement point                           |
| TP2_P1     | T-H Loop | SW_P1       | Switching node of output rail phase 1 measurement point, reference to TP4_P1 |
| TP2_P2     | T-H Loop | SW_P2       | Switching node of output rail phase 2 measurement point, reference to TP4_P2 |
| TP3_P1     | T-H Loop | GND_P1      | GND pin voltage of U1_P1 device measurement point                            |
| TP3_P2     | T-H Loop | GND_P2      | GND pin voltage of U1_P2 device measurement point                            |
| TP4_P1     | T-H Loop | GND_P1      | GND reference for switch node measurement of U1_P1                           |
| TP4_P2     | T-H Loop | GND_P2      | GND reference for switch node measurement of U1_P2                           |
| TP5_P1     | T-H Loop | PG_S_P1     | PGOOD signal of phase 1                                                      |
| TP5_P2     | T-H Loop | PG_S_P2     | PGOOD signal of phase 2                                                      |
| TP6        | T-H Loop | AUX_5V      | External 5V measurement point for VDD5                                       |
| TP7        | T-H Loop | DATA        | DATA signal on J2 header                                                     |
| TP8        | T-H Loop | SMBALRT     | SMBALERT signal on J2 header                                                 |
| TP9        | T-H Loop | CNTL        | CNTL signal on J2 header                                                     |
| TP10       | T-H Loop | CLK         | CLK signal on J2 header                                                      |
| TP11       | T-H Loop | GND         | GND reference                                                                |
| TP12       | T-H Loop | PVIN        | VIN+ measurement point                                                       |
| TP13       | T-H Loop | VOUT_P1     | U1_P1 output voltage measurement point for efficiency, reference to TP16     |
| TP14       | T-H Loop | Remote SNS+ | OUTPUT remote sense + voltage point                                          |
| TP15       | T-H Loop | GND         | VIN- measurement point                                                       |
| TP16       | T-H Loop | GND_P1      | U1_P1 output voltage referencing GND for efficiency measurement              |
| TP17       | T-H Loop | CH_A        | OUTPUT for small signal loop gain measurements (B/A setup)                   |
| TP18       | T-H Loop | CH_B        | INPUT for small signal loop gain measurements (B/A setup)                    |
| TP19       | T-H Loop | Ext_AVIN    | AVIN measurement point                                                       |
| TP20       | T-H Loop | GND         | GND reference                                                                |
| TP21       | T-H Loop | VSHARE      | VSHARE measurement point. Sensitive signal.                                  |

**Table 2. Test Point Functions (continued)**

| Test Point              | Type     | Name                  | Description                                                              |
|-------------------------|----------|-----------------------|--------------------------------------------------------------------------|
| TP22                    | T-H Loop | VOUT                  | VOUT + measurement point                                                 |
| TP23                    | T-H Loop | GND                   | GND reference                                                            |
| TP24                    | T-H Loop | GND                   | GND reference                                                            |
| TP25                    | T-H Loop | GND                   | VOUT - measurement point                                                 |
| TP26                    | T-H Loop | VOUT_P2               | U1_P2 output voltage measurement point for efficiency, reference to TP30 |
| TP27                    | T-H Loop | SYNC                  | Synchronization connection between U1_P1 and U1_P2. External SYNC input. |
| TP28                    | T-H Loop | Remote SNS-           | OUTPUT remote sense - voltage point                                      |
| TP29                    | T-H Loop | BC_DAT                | Data for back-channel communications between stacked devices             |
| TP30                    | T-H Loop | GND_P2                | U1_P2 output voltage referencing GND for efficiency measurement          |
| TP31                    | T-H Loop | BC_CLK                | Clock for back-channel communications between stacked devices            |
| TP32                    | T-H Loop | GND                   | GND reference                                                            |
| TP33                    | T-H Loop | VOSNS_P2              | VOSNS measurement point for U1_P2                                        |
| TP34_P1<br>,<br>TP34_P2 | T-H Loop | MSEL2_P1,<br>MSEL2_P2 | MSEL2 measurement point for U1_P1 and U1_P2                              |
| TP35_P1<br>,<br>TP35_P2 | T-H Loop | VSEL_P1,<br>VSEL_P2   | VSEL measurement point for U1_P1 and U1_P2                               |

Table 3 lists the EVM jumpers.

**Table 3. Jumpers**

| Jumper            | Type                   | Name                     | Description                                                  |
|-------------------|------------------------|--------------------------|--------------------------------------------------------------|
| JP1_P1,<br>JP1_P2 | Header, 100 mil, 2 × 1 | EXT_5.1V_P1, EXT_5.1V_P2 | Short to connect VDD5 of U1_P1 or U1_P2 to the 5.1 V from U2 |
| JP2_P1,<br>JP2_P2 | Header, 100 mil, 3 × 2 | CNTL_SEL1, CNTL_SEL2     | U1_P1 and U1_P2 EN/UVLO pin selections                       |
| JP3               | Header, 100 mil, 2 × 1 | EN to GND                | Short to disable the auxiliary 5 V                           |
| JP4               | Header, 100 mil, 2 × 1 | AVIN-PVIN                | Short to connect to connect AVIN input to PVIN               |
| JP5               | Header, 100 mil, 2 × 1 | AVIN-LDO                 | Short to connect to connect AVIN input to U2 input           |
| JP6               | Header, 100 mil, 2 × 1 | PMBus3.3V-AVIN           | Short to connect USB-to-GPIO 3.3V to AVIN                    |
| JP7_P1,<br>JP7_P2 | Header, 100 mil, 3 × 1 | AVIN-U1_P1, AVIN-U1_P2   | U1_P1 and U1_P2 AVIN input source selections                 |
| JP8               | Header, 100 mil, 2 × 1 | Micro_USB-PVIN           | Short to connect PVIN to Micro USB connector                 |

Table 4 lists the options for the EN/UVLO pin selections on JP2\_P1 and JP2\_P2.

**Table 4. JP2\_P1 and JP2\_P2 Selections**

| Shunt Position     | Selection                    |
|--------------------|------------------------------|
| pin 1 to 2 shorted | PMBus adaptor control signal |
| pin 3 to 4 shorted | Resistor divider to PVIN     |
| pin 5 to 6 shorted | EN/UVLO short to ground      |

Table 5 lists the options for the EN/UVLO pin selections on JP2\_P1 and JP2\_P2.

**Table 5. JP7\_P1 and JP7\_P2 Selections**

| Shunt Position     | Selection                                                                                                        |
|--------------------|------------------------------------------------------------------------------------------------------------------|
| pin 1 to 2 shorted | AVIN pin connected to AVIN input through 10-Ω resistor. Use this selection when testing with a split rail input. |
| pin 2 to 3 shorted | AVIN pin connected to PVIN through 10-Ω resistor                                                                 |

Table 6 lists the EVM connector functions.

**Table 6. Connector Functions**

| Connector | Type                   | Name            | Description                                            |
|-----------|------------------------|-----------------|--------------------------------------------------------|
| J1        | Header, 100 mil, 6 × 2 | N/A             | Do not use                                             |
| J2        | Header, 100 mil, 5 × 2 | PMBus connector | PMBus socket for TI FUSION adaptor                     |
| J3        | Header, 100 mil, 6 × 2 | N/A             | Do not use                                             |
| J4        | Micro USB              | Micro USB       | Micro USB connector to power EVM from a 5 V USB source |
| T1        | Terminal block, 2 × 1  | PVIN            | VIN+ connector                                         |
| T2        | Terminal block, 2 × 1  | GND             | VIN– connector                                         |
| T3        | Terminal 90A Lug       | VOUT            | VOUT+ connector                                        |
| T4        | Terminal block, 2 × 1  | Ext_AVIN        | External AVIN connector                                |
| T5        | Terminal 90A Lug       | GND             | VOUT– connector                                        |

## 4.5 Evaluating Single Phase Operation

The default configuration of the EVM is for 2-phase operation. For a single-phase operation, modify the EVM as follows:

1. Short MSEL2 of U1\_P1 to GND to program single-phase operation by populating R18\_P1 with a 0-Ω resistor.
2. If U1\_P2 is left populated, disconnect VSHARE of the slave device from the master by depopulating R15\_P1 (this is a 0-Ω resistor and can be used for MSEL2 pin of U1\_P1 in the previous step).
3. If U1\_P2 is left populated, disable U1\_P2 by moving the JP2\_P2 jumper to position 5-6 (GND).

---

**NOTE:** This will leave the AVIN (pin 26) of U1\_P2 powered, if no-load leakage current or light-light efficiency measurement is important, the U1\_P2 AVIN pin should also be disconnected from the input supply. Disconnect the slave U1\_P2 AVIN from  $V_{IN}$  by removing the jumper from JP7\_P2.

---

## 4.6 Evaluating Split Rail Input

The default configuration of the EVM is for single rail input. Split rail input enables operation with 3.3V PVIN. For split rail operation configure the jumpers on the EVM as follows:

1. Open JP4 to disconnect AVIN from PVIN.
2. Move the jumper JP7\_P1 and JP7\_P2 to position 1-2 to disconnect the AVIN pin from the PVIN pins.
3. Apply the AVIN input to T4. 4-V or greater AVIN is required to bring the VDD5 voltage high enough to enable conversion.
4. If operation with 3.3-V PVIN is needed and the CNTL Jumpers (JP2\_P1 and JP2\_P2) are in position 3-4, the resistor divider at the EN/UVLO will need to be changed. Alternately move the CNTL Jumpers to position 1-2 and use the control signal to enable conversion or use the ON\_OFF\_CONFIG and OPERATION commands to enable conversion.

## 4.7 Configuring EVM to Overdrive VDD5

The EVM has an external LDO (U2) that can be used to overdrive VDD5. The output of this LDO is set for 5.1 V by default. This LDO is useful to minimize the power dissipation in the TPS546D24A IC when using a single rail input. Overdriving VDD5 moves the loss from the internal LDO of the TPS546D24A to the external LDO (U2). To use this LDO, configure the jumpers on the EVM as follows:

1. Short JP4 and JP5 to connect the input of the LDO to the input supply.
2. Open JP3 to enable the LDO.
3. Short JP1\_P1 and JP1\_P2 to connect the LDO output to the VDD5 pin.
4. Ensure the VDD5 output of the TPS546D24A is set below the external LDO's output voltage.

## 5 EVM Configuration Using the Fusion GUI

The TPS546D24A IC leaves the factory pre-configured. The factory default settings for the parameters can be found in the datasheet. If configuring the EVM to settings other than the factory defaults, use the software described in [Section 4.1](#). It is necessary to have the input voltage applied to the EVM prior to launching the software so that the TPS546D24A may respond to the GUI and the GUI can recognize the device. The default configuration for the EVM to stop converting is set by the EN/UVLO resistor divider to a nominal input voltage of 4.75 V; therefore if it is necessary to avoid any converter activity during configuration, an input voltage less than 4.75 V should be applied. TI recommends an input voltage of 3.3 V.

### 5.1 Configuration Procedure

1. Adjust the input supply to provide 3.3 VDC, current limited to 1 A.
2. Apply the input voltage to the EVM. See [Section 4.2](#) for connections and test setup.
3. Launch the Fusion GUI software. See the screen shots in [Section 10](#) for more information.
4. Configure the EVM operating parameters as desired.

By default the pinstrap resistors configure U1\_P1 as the loop master and U1\_P2 as the loop slave.

## 6 Test Procedure

### 6.1 Line and Load Regulation and Efficiency Measurement Procedure

1. Set up the EVM as [Section 4.2](#) and [Section 6.2](#) describe.
2. Set the electronic load to draw 0 A<sub>DC</sub>.
3. Increase V<sub>IN</sub> from 0 V to 12 V using voltage meter to measure input voltage.
4. Use the other voltage meter to measure output voltage V<sub>OUT</sub>.
5. Vary the load from 0 to 80 A<sub>DC</sub>. V<sub>OUT</sub> should remain in regulation as defined in [Table 1](#).
6. Vary V<sub>IN</sub> from 5 V to 16 V. V<sub>OUT</sub> should remain in regulation as defined in [Table 1](#).
7. Decrease the load to 0 A.
8. Decrease V<sub>IN</sub> to 0 V.

## 6.2 Efficiency Measurement Test Points

To evaluate the efficiency of the power train (device and inductor), it is important to measure the voltages at the correct location. This is necessary because otherwise the measurements will include losses that are not related to the power train itself. Losses incurred by the voltage drop in the copper traces and in the input and output connectors are not related to the efficiency of the power train, which should not be included in efficiency measurements.

Input current can be measured at any point in the input wires, and output current can be measured anywhere in the output wires of the output being measured.

[Table 7](#) shows the measurement points for input voltage and output voltage. VIN and VOUT are measured to calculate the efficiency. Using these measurement points will result in efficiency measurements that excluded losses due to the wires and connectors.

**Table 7. Test Points for Efficiency Measurements**

| Test Point | Node Name | Description                                      | Comment                                                                                                                                                                                 |
|------------|-----------|--------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TP12       | PVIN      | Input voltage measurement point for VIN+         | The pair of test points are connected to the PVIN/PGND pins of U1_P1. The voltage drop between input terminal to the device pins is included for efficiency measurement.                |
| TP15       | PGND      | Input voltage measurement point for VIN– (GND)   |                                                                                                                                                                                         |
| TP22       | VOUT      | Output voltage measurement point for VOUT+       | The pair of test points are connected near the output terminals. The voltage drop from the output point of the inductor to the output terminals is included for efficiency measurement. |
| TP25       | GND       | Output voltage measurement point for VOUT– (GND) |                                                                                                                                                                                         |

For more accurate efficiency measurements of the power train, the voltage drop between the power train and the terminals should also be removed from the measurement. Using the test points in [Table 8](#) will reduce these losses. To average the voltages at each test point so that only one meter is needed for PVIN and VOUT, add some resistance between the each test point and the meter. For the measurements taken in this user's guide, a 1.5-k $\Omega$  resistor was added in series with each test point. Using these test points reduced the measured power loss at 80 A load by approximately 0.5 W. This power is lost in the copper traces of the PCB.

**Table 8. Test Points for Better Efficiency Measurements**

| Test Point | Node Name | Description                                      | Comment                                                                                   |
|------------|-----------|--------------------------------------------------|-------------------------------------------------------------------------------------------|
| TP1_P1     | PVIN_P1   | Input voltage measurement point for VIN+         | This pair of test points are connected to PVIN and PGND near the pins of U1_P1            |
| TP4_P1     | GND_P1    | Input voltage measurement point for VIN– (PGND)  |                                                                                           |
| TP1_P2     | PVIN_P2   | Input voltage measurement point for VIN+         | This pair of test points are connected to PVIN and PGND near the pins of U1_P2            |
| TP4_P2     | GND_P2    | Input voltage measurement point for VIN– (PGND)  |                                                                                           |
| TP13       | VOUT_P1   | Output voltage measurement point for VOUT+       | This pair of test points are connected to VOUT and GND near the output inductor for U1_P1 |
| TP16       | GND_P1    | Output voltage measurement point for VOUT– (GND) |                                                                                           |
| TP26       | VOUT_P2   | Output voltage measurement point for VOUT+       | This pair of test points are connected to VOUT and GND near the output inductor for U1_P2 |
| TP30       | GND_P2    | Output voltage measurement point for VOUT– (GND) |                                                                                           |

### 6.3 Control Loop Gain and Phase Measurement Procedure

The TPS546D24AEVM-2PH includes a 49.9- $\Omega$  series resistor in the feedback loop for  $V_{OUT}$ . The resistor is accessible at the test points TP17 and TP18 for loop response analysis. These test points should be used during loop response measurements as the perturbation injecting points for the loop. See the description in [Table 9](#).

**Table 9. List of Test Points for Loop Response Measurements**

| Test Point | Node Name | Description                            | Comment                                                                             |
|------------|-----------|----------------------------------------|-------------------------------------------------------------------------------------|
| TP18       | CH_B      | Input to feedback divider of $V_{OUT}$ | The amplitude of the perturbation at this node should be limited to less than 30 mV |
| TP17       | CH_A      | Resulting output of $V_{OUT}$          | Bode can be measured by a network analyzer with a CH_B/CH_A configuration           |

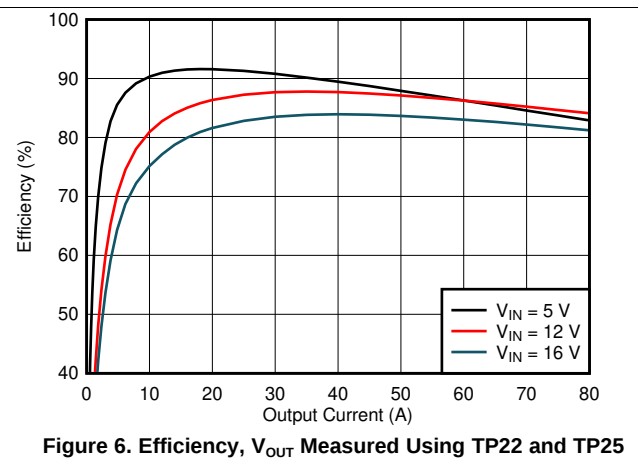
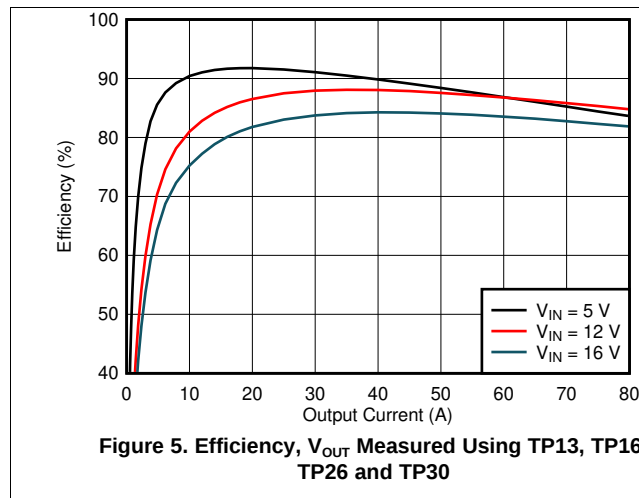
Measure the loop response with the following procedure:

1. Set up the EVM as described in [Section 4.2](#).
2. For  $V_{OUT}$ , connect the isolation transformer of the network analyzer from TP18 to TP17.
3. Connect the input signal measurement probe to TP18. Connect the output signal measurement probe to TP17.
4. Connect the ground leads of both probe channels to TP20.
5. On the network analyzer, measure the Bode as TP18/TP17 (In/Out).

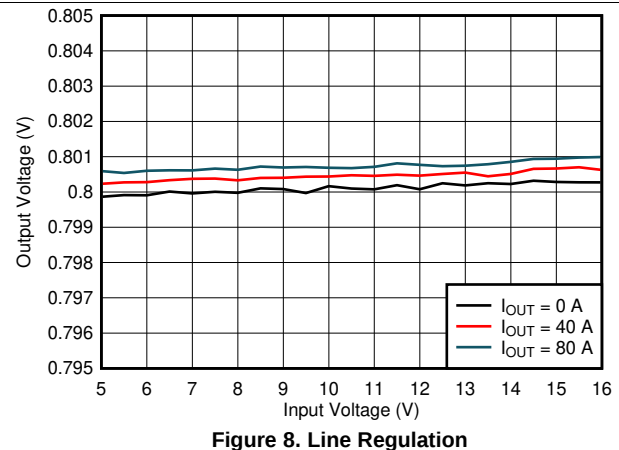
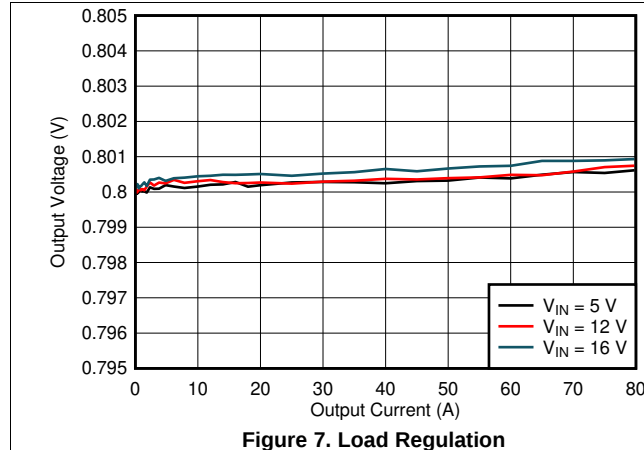
## 7 Performance Data and Typical Characteristic Curves

Figure 5 through Figure 8 present typical performance curves for the TPS546D24AEVM-2PH. The input voltage is 12 V and the oscilloscope measurements use 20 MHz bandwidth limiting unless otherwise noted.

### 7.1 Efficiency

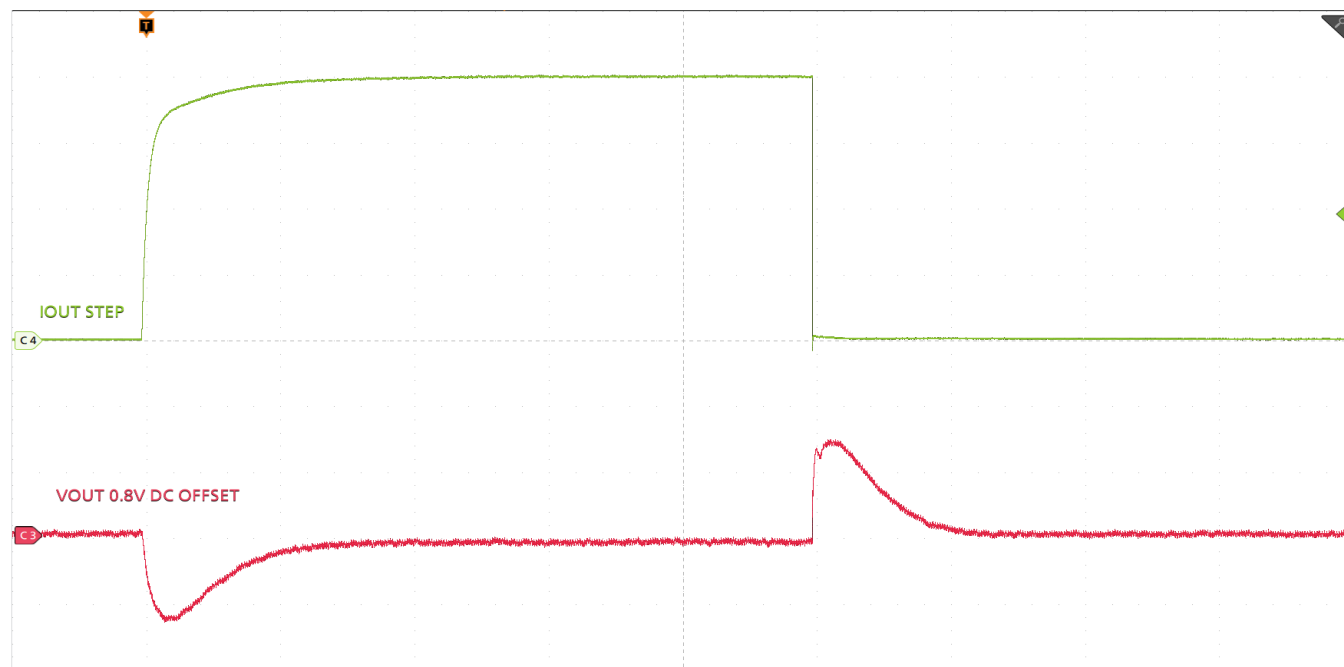


### 7.2 Load and Line Regulation (Measured Between TP22 and TP25)



### 7.3 Transient Response

Figure 9 shows the transient response waveform with a 20 A to 60 A transient at 1 A/ $\mu$ s

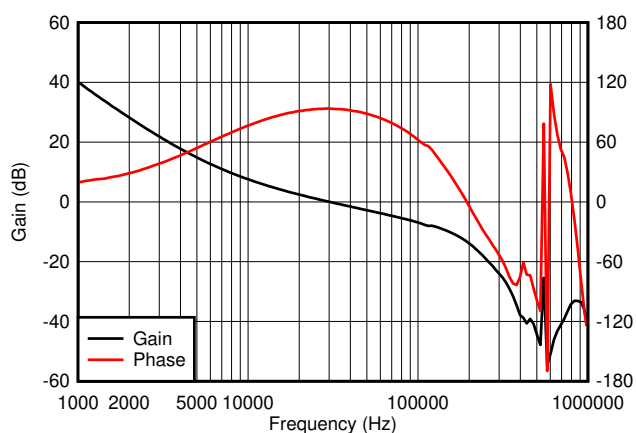


Timescale = 100  $\mu$ s/div, CH4 =  $I_{OUT}$  STEP at 10 A/div, CH3 =  $V_{OUT}$  at 50 mV/division

**Figure 9. Transient Response**

### 7.4 Control Loop Bode Plot

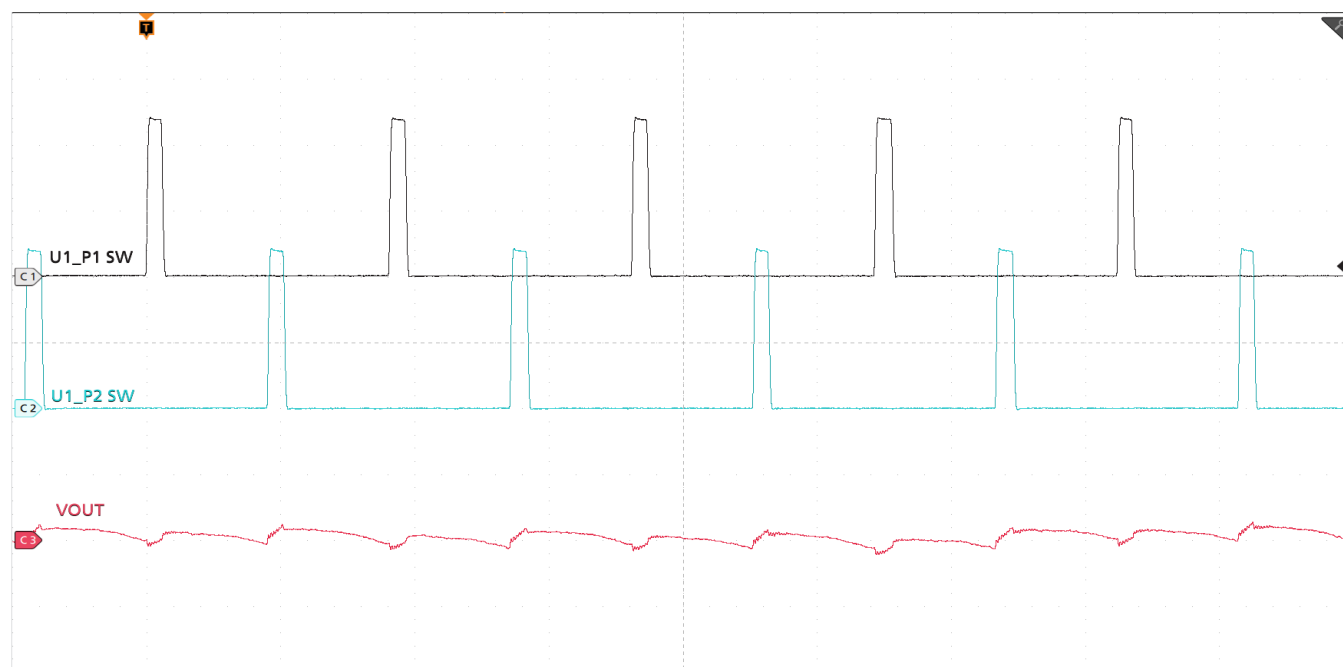
Figure 10 is the control loop bode plot.



**Figure 10. Bode Plot at 0.8-V Output at 12  $V_{IN}$ , 20-A Load**

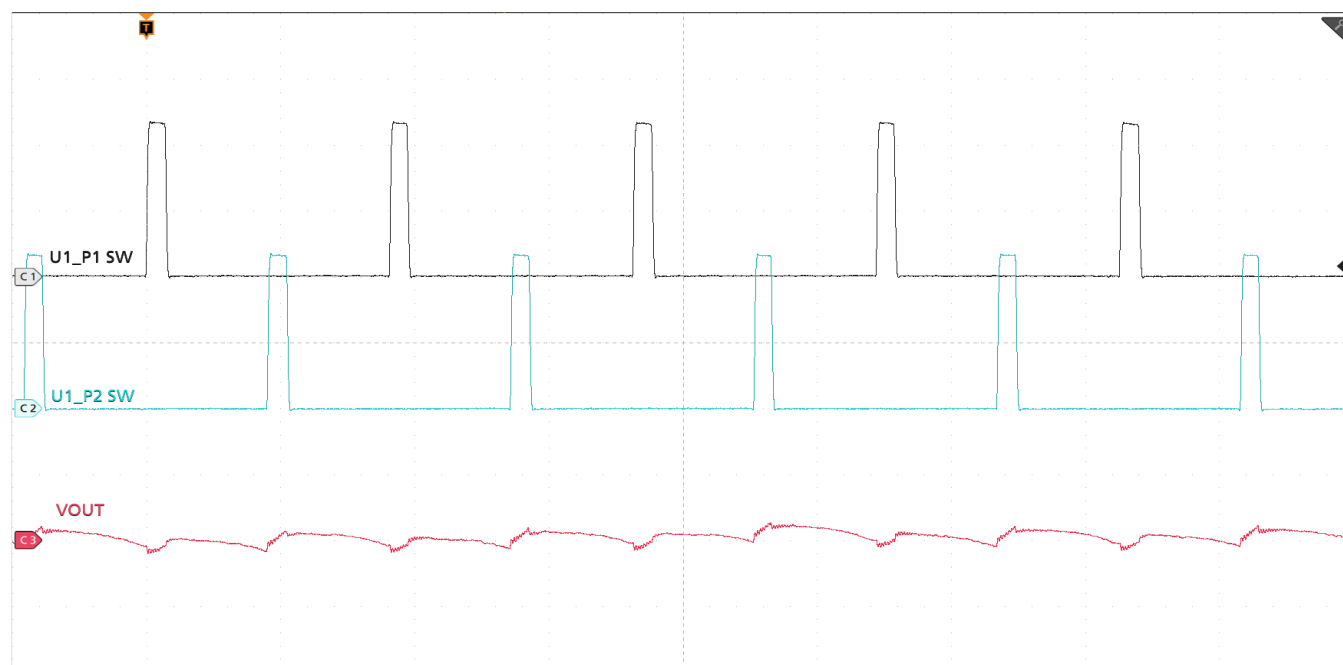
## 7.5 Output Ripple

Figure 11 and Figure 12 show the output ripple waveforms at 0-A and 80-A load.



Timescale = 1  $\mu$ s/div, CH1 = SW1 at 5 V/div, CH2 = SW2 at 5 V/div, CH3 =  $V_{OUT}$  at 10 mV/div

**Figure 11. Output Ripple With 0-A Load**

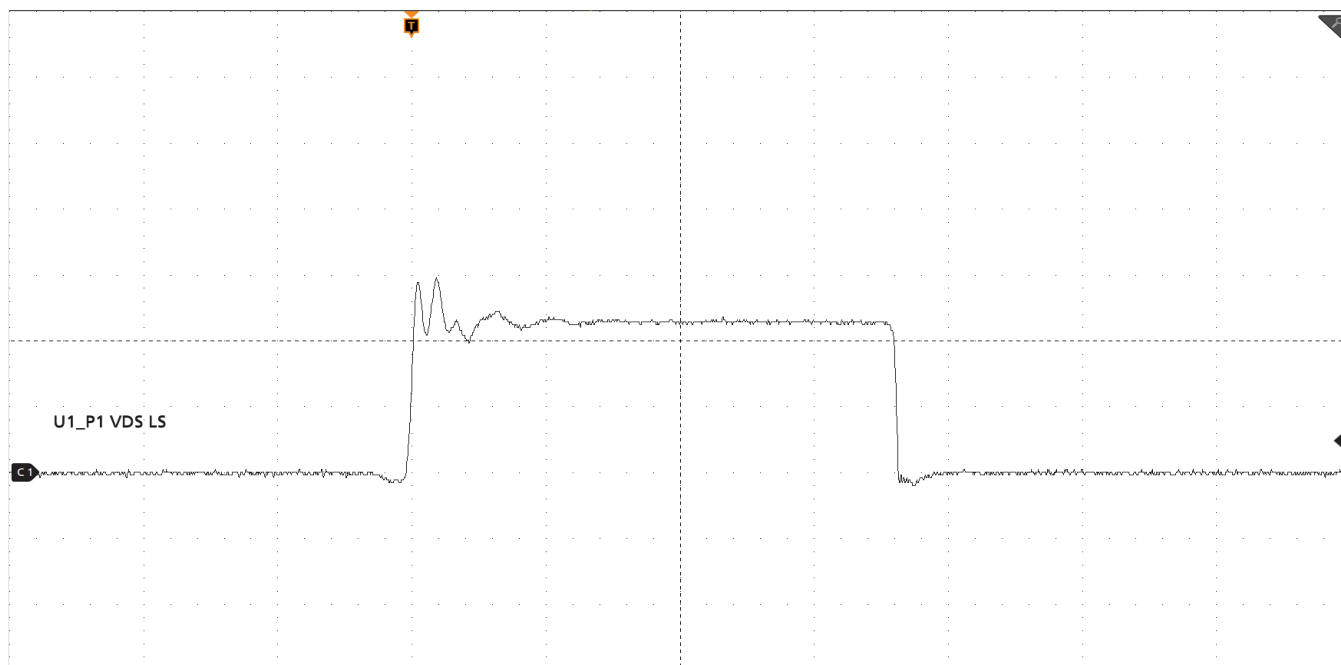


Timescale = 1  $\mu$ s/div, CH1 = SW1 at 5 V/div, CH2 = SW2 at 5 V/div, CH3 =  $V_{OUT}$  at 10 mV/div

**Figure 12. Output Ripple With 80-A Load**

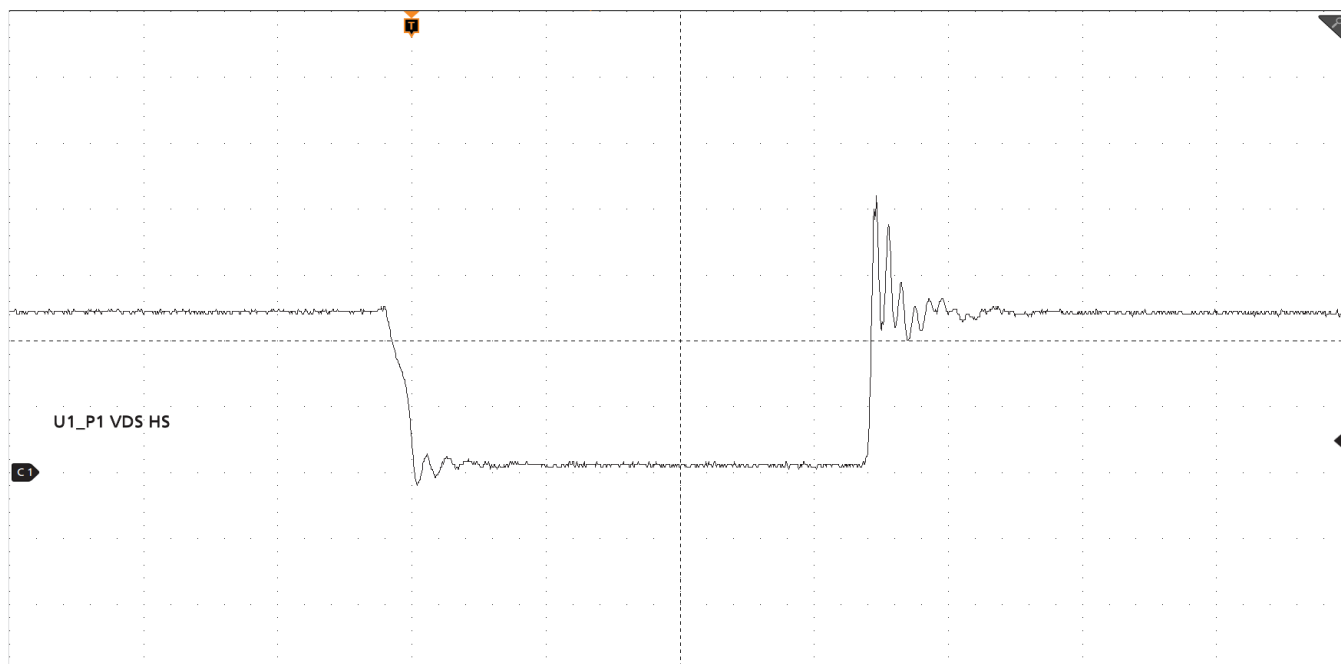
## 7.6 Power MOSFET Drain-Source Voltage

Figure 13 and Figure 14 show the low-side and high-side MOSFET drain-source voltage ( $V_{DS}$ ) at 80-A load. The voltage is measured with 1-GHz bandwidth and at the solder mask openings near the U1\_P1 IC using a 1-GHz differential probe.



Timescale = 40 ns/div, CH1 = Low-side  $V_{DS}$  at 5 V/div

**Figure 13. Low-side MOSFET  $V_{DS}$**

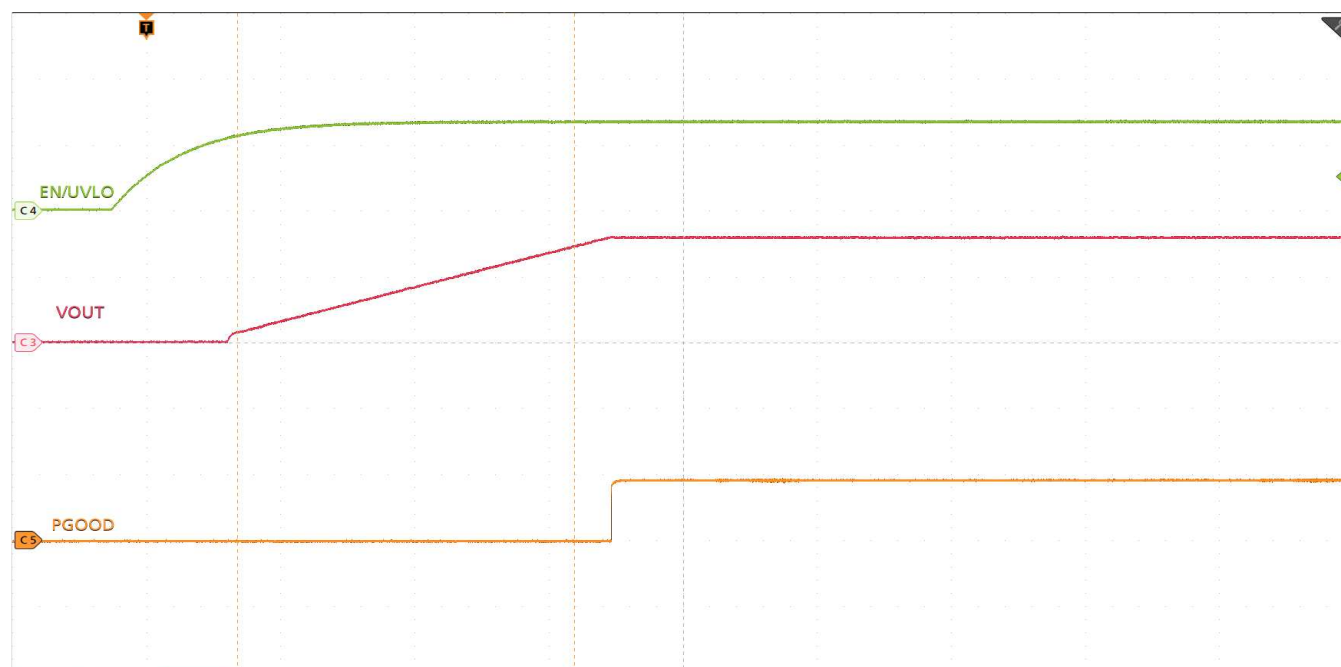


Timescale = 40 ns/div, CH1 = High-side  $V_{DS}$  at 5 V/div

**Figure 14. High-side MOSFET  $V_{DS}$**

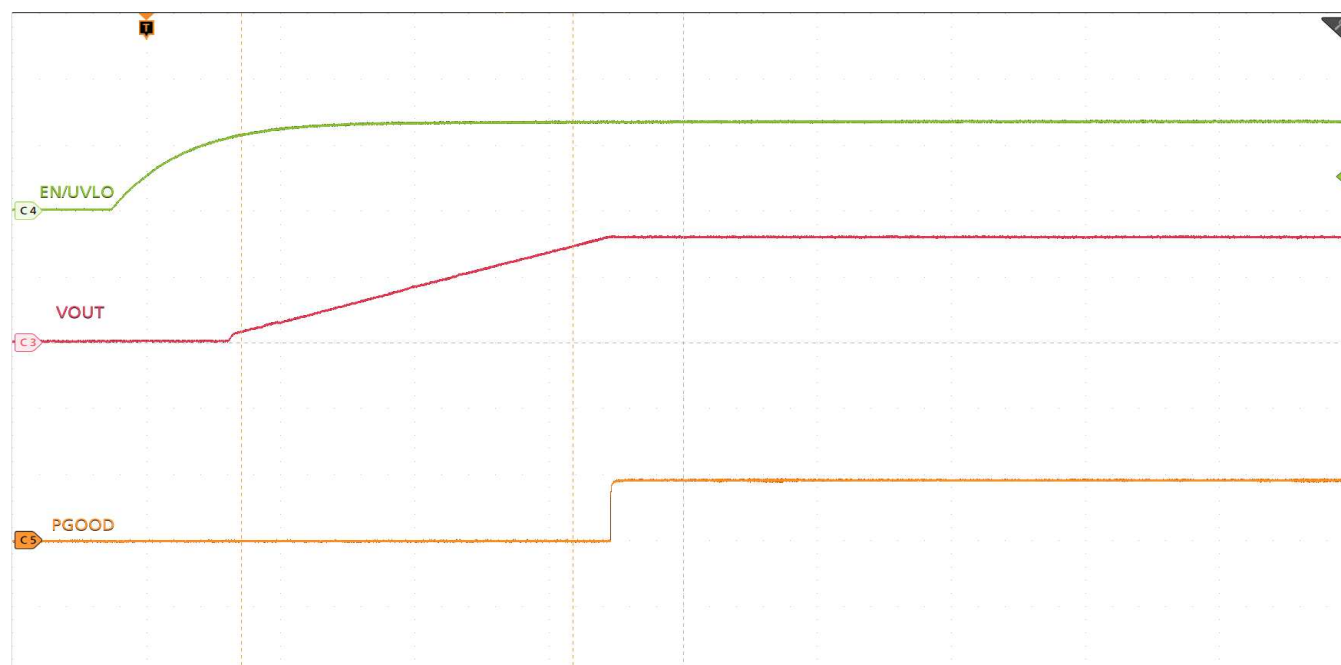
## 7.7 Control On

Figure 15 and Figure 16 illustrate the start-up from control on waveforms at 0-A and 80-A output.



Timescale = 1 ms/div, CH3 =  $V_{OUT}$  at 500mV/div, CH4 = EN/UVLO at 2 V/div, CH5 = PGOOD at 5 V/div

**Figure 15. Start-Up From Control, 0-A Load**



Timescale = 1 ms/div, CH3 =  $V_{OUT}$  at 500mV/div, CH4 = EN/UVLO at 2 V/div, CH5 = PGOOD at 5 V/div

**Figure 16. Start-Up From Control, 80-A CC Load**

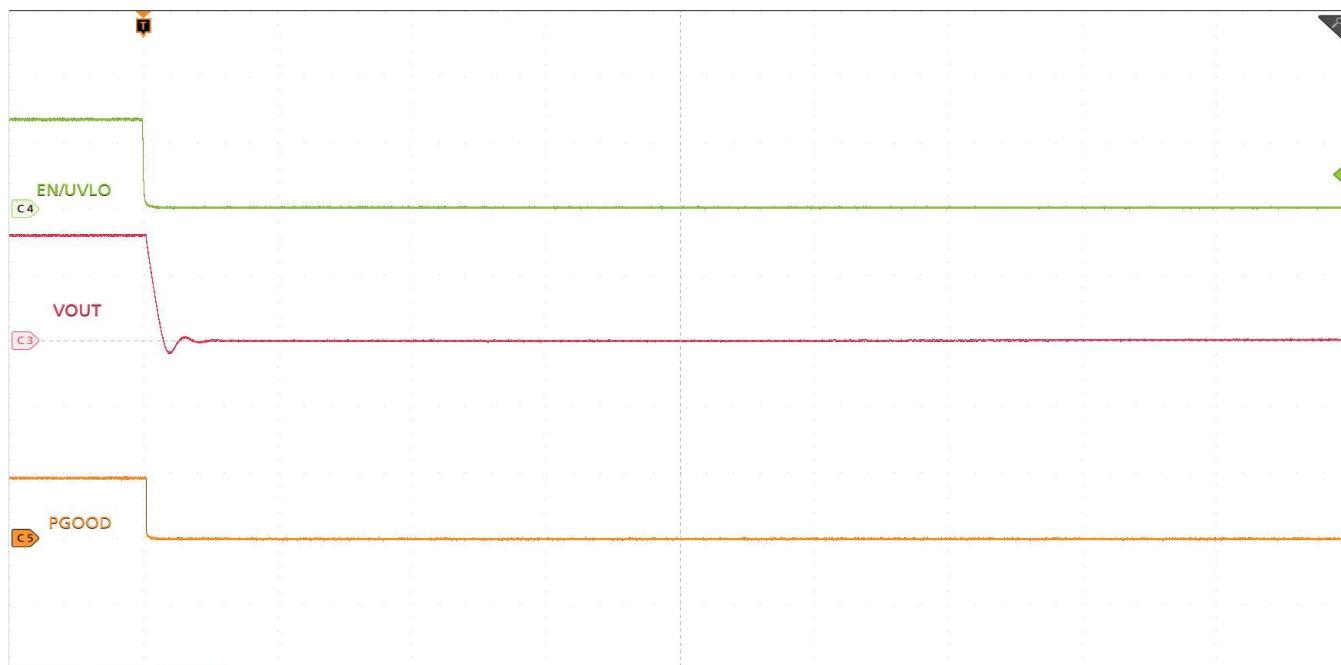
## 7.8 Control Off

Figure 17 and Figure 18 illustrate the control off waveforms at 0-A and 20-A outputs, respectively.



Timescale = 1 ms/div, CH3 =  $V_{OUT}$  at 500mV/div, CH4 = EN/UVLO at 2 V/div, CH5 = PGOOD at 5 V/div

**Figure 17. Shutdown From Control, 0-A Load**

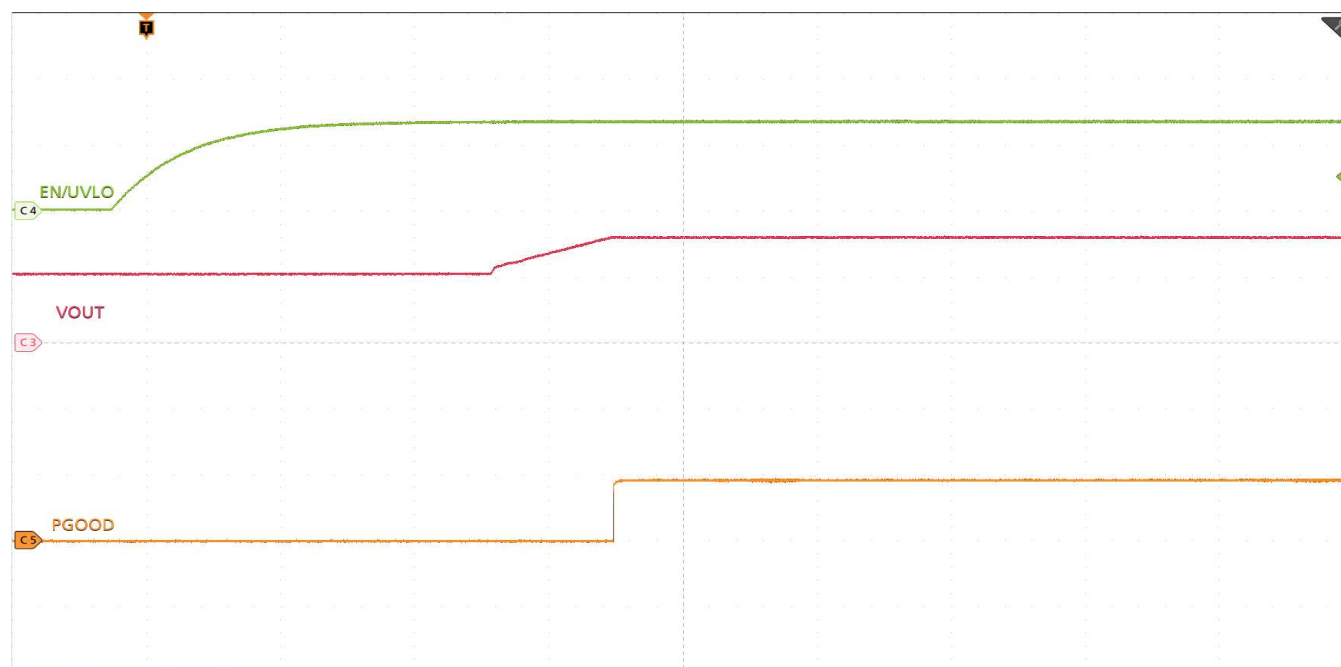


Timescale = 1 ms/div, CH3 =  $V_{OUT}$  at 500mV/div, CH4 = EN/UVLO at 2 V/div, CH5 = PGOOD at 5 V/div

**Figure 18. Shutdown From Control, 20-A CC Load**

## 7.9 Control On With Pre-biased Output

Figure 19 illustrates the control on waveforms with a pre-biased output voltage.

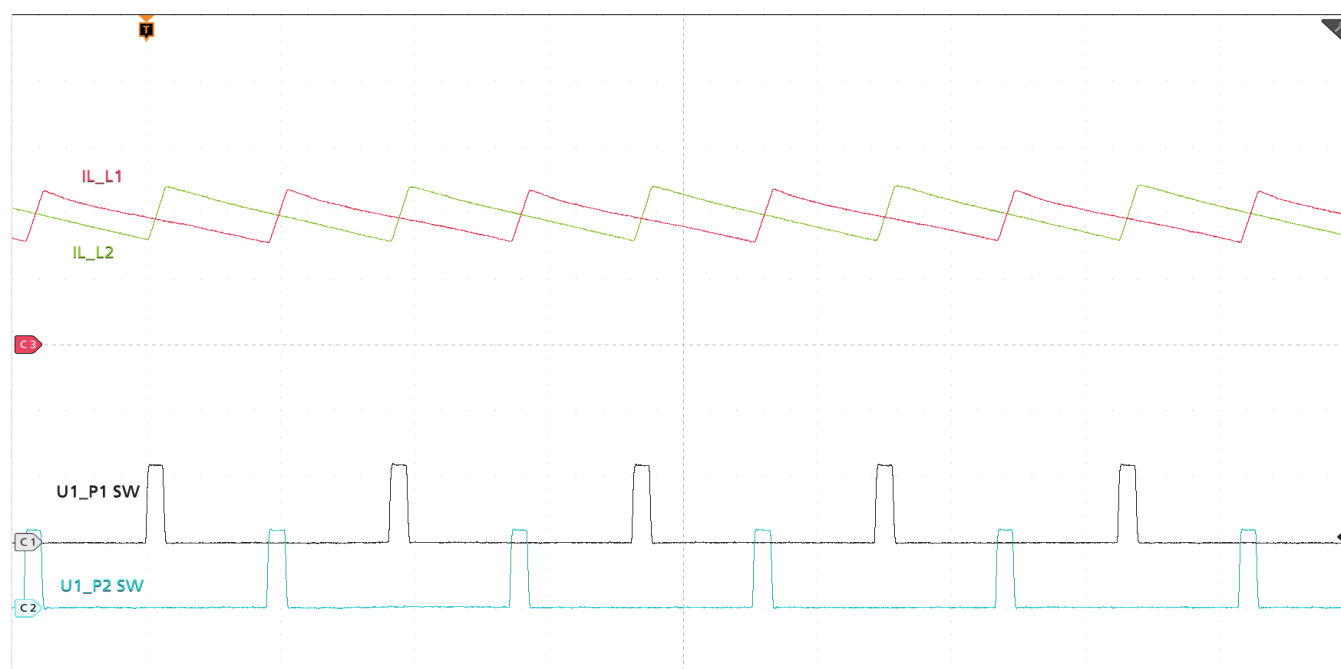


Timescale = 1 ms/div, CH3 =  $V_{OUT}$  at 500mV/div, CH4 = EN/UVLO at 2 V/div, CH5 = PGOOD at 5 V/div

**Figure 19. Start-Up From Control With Pre-biased Output**

## 7.10 Current Sharing Between Two Phases

Figure 20 illustrates the current sharing between two phases.

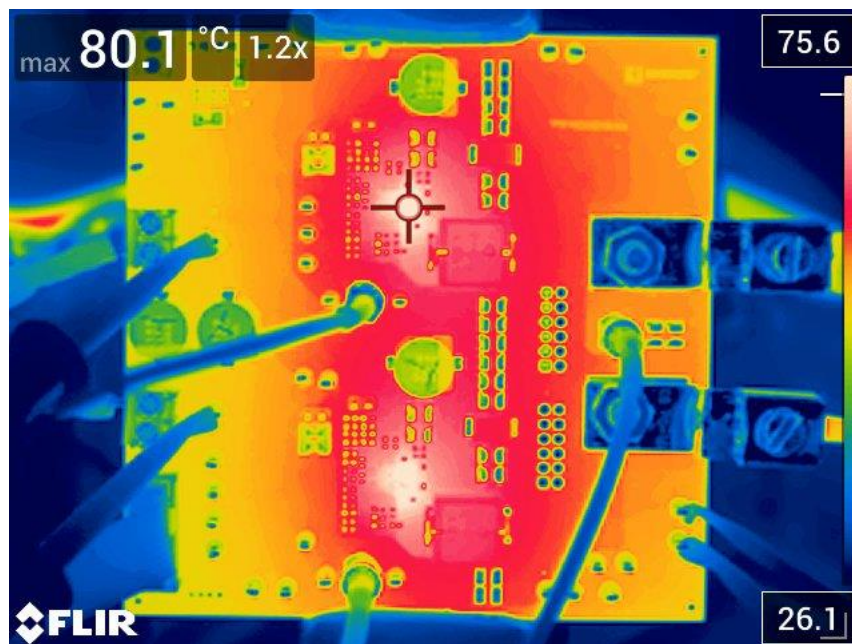


Timescale = 1  $\mu$ s/div, CH1 = SW1 at 10 V/div, CH2 = SW2 at 10 V/div, CH3 = IL1 at 10 A/div, CH4 = IL2 at 10 A/div

**Figure 20. Inductor Current and Switch Node Waveform, 40-A Load**

## 7.11 Thermal Image

Figure 21 shows the TPS546D24AEVM-2PH thermal image.



$V_{IN} = 12\text{ V}$ ,  $I_{OUT} = 80\text{ A}$

**Figure 21. Thermal Image**

## 8 EVM Assembly Drawing and PCB Layout

Figure 22 through Figure 29 show the design of the TPS546D24AEVM-2PH printed circuit board.

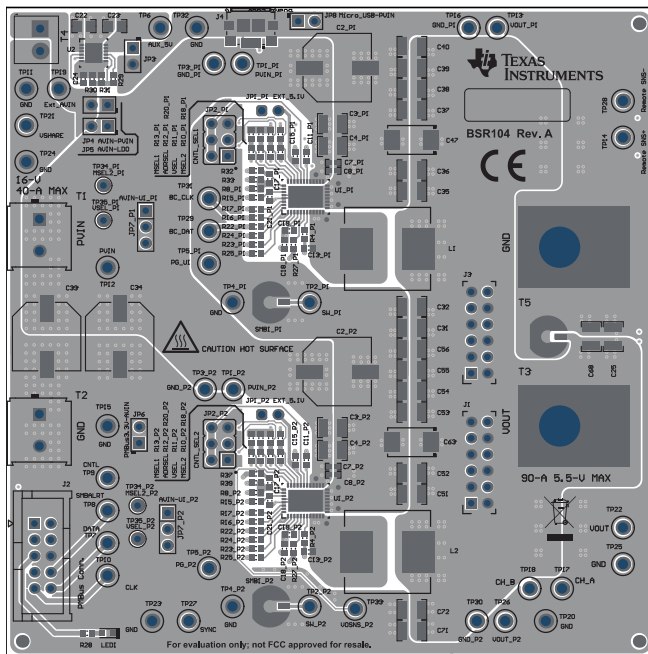


Figure 22. TPS546D24AEVM-2PH Top Side Component View (Top View)

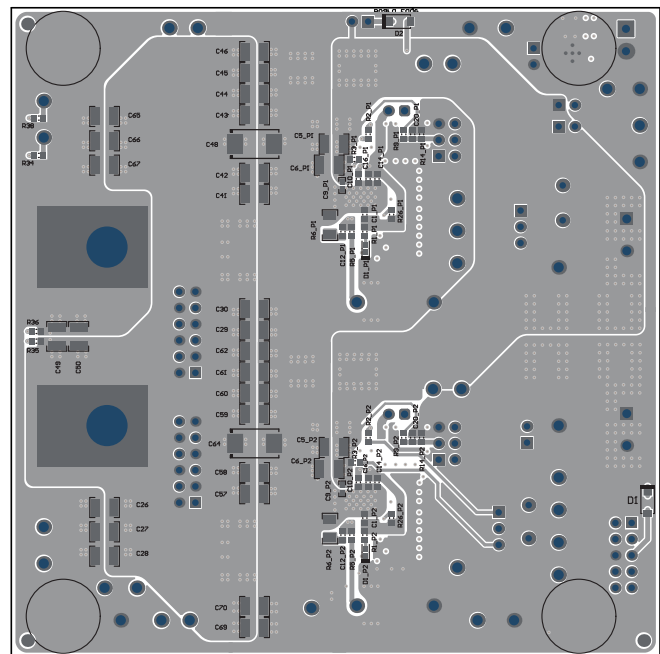


Figure 23. TPS546D24AEVM-2PH Bottom Side Component View (Bottom View)

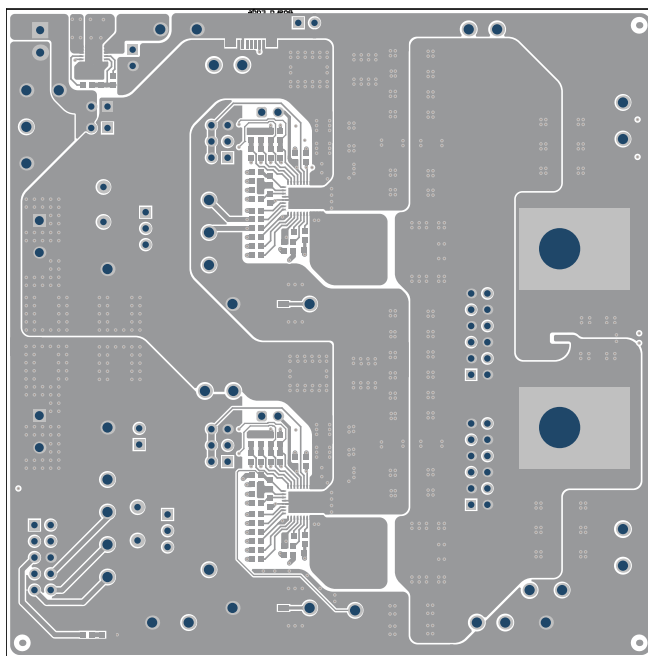


Figure 24. TPS546D24AEVM-2PH Top Copper (Top View)

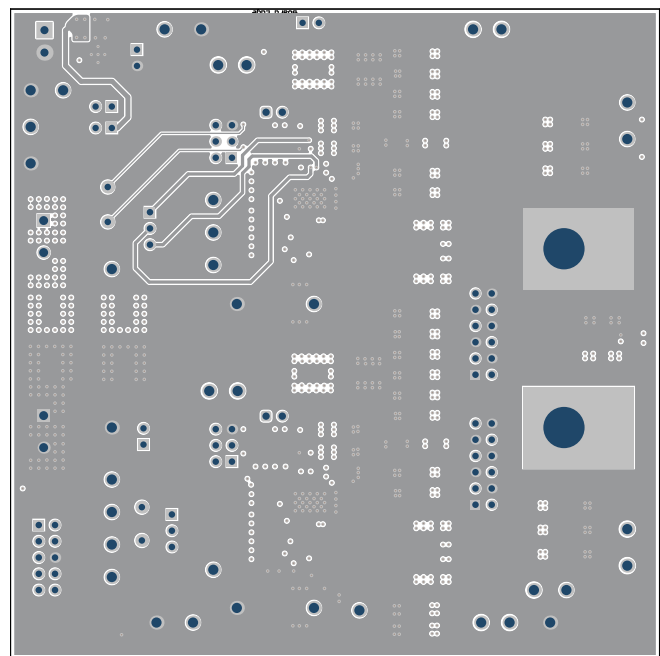
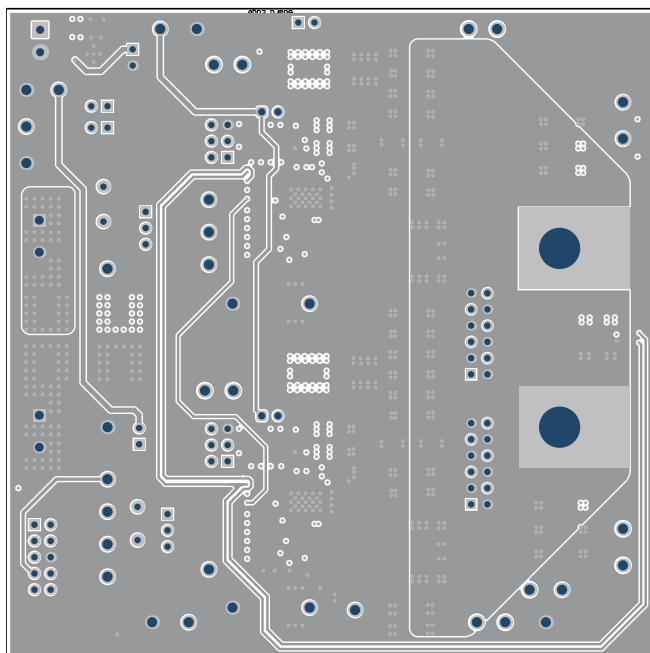
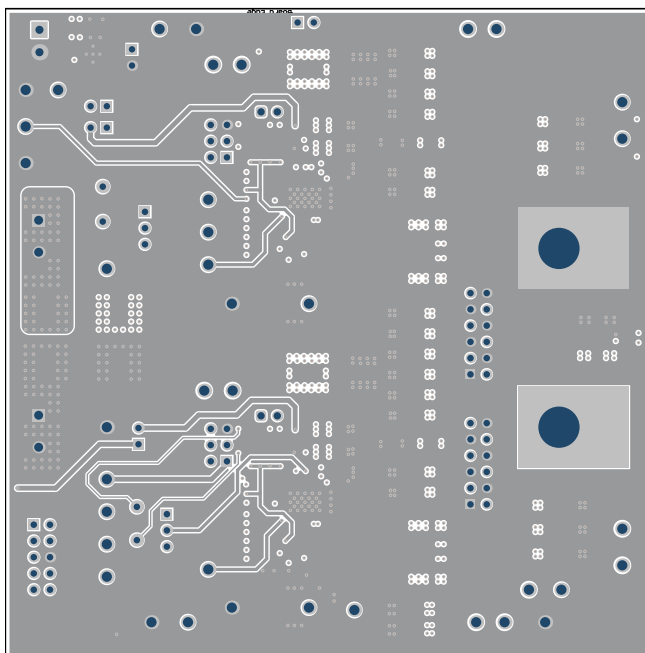


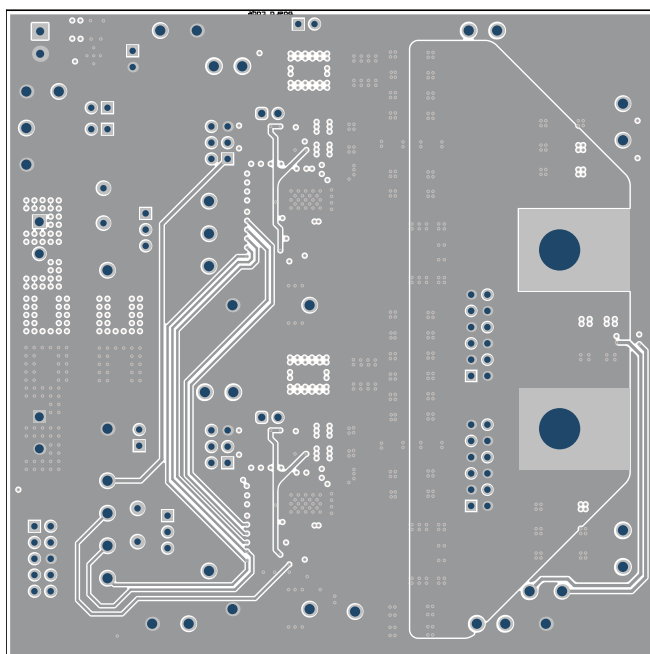
Figure 25. TPS546D24AEVM-2PH Internal Layer 1 (Top View)



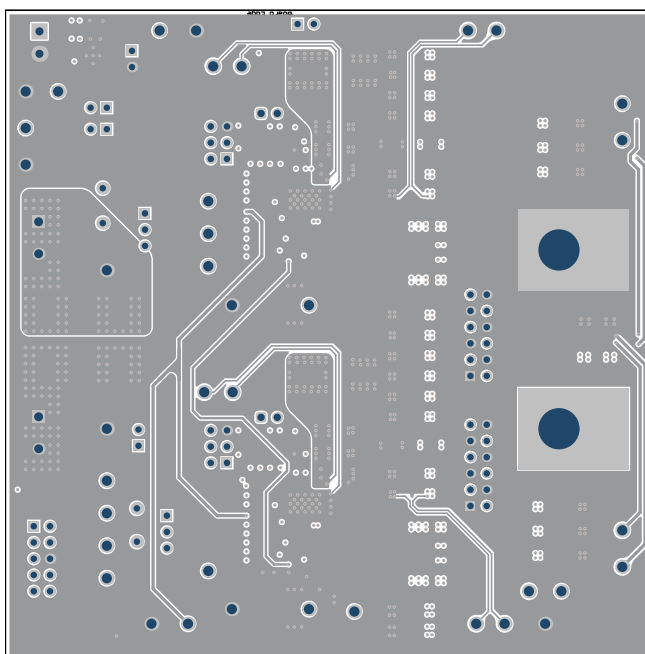
**Figure 26. TPS546D24AEVM-2PH Internal Layer 2 (Top View)**



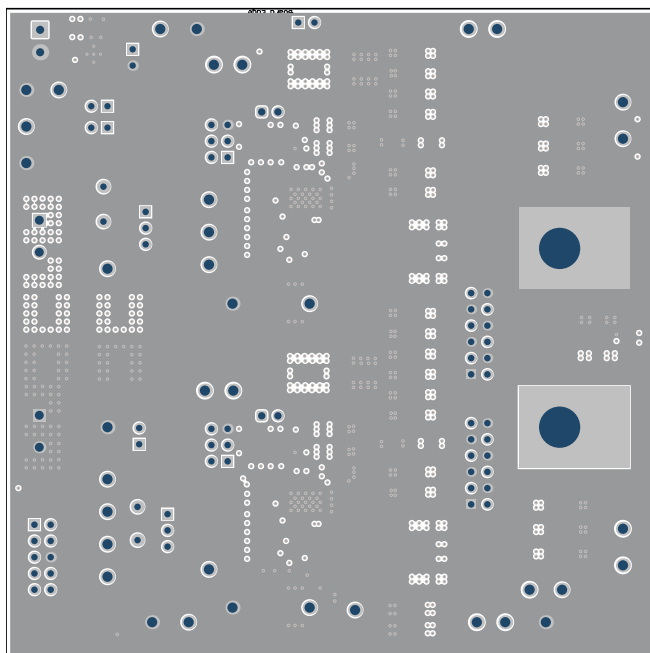
**Figure 27. TPS546D24AEVM-2PH Internal Layer 3 (Top View)**



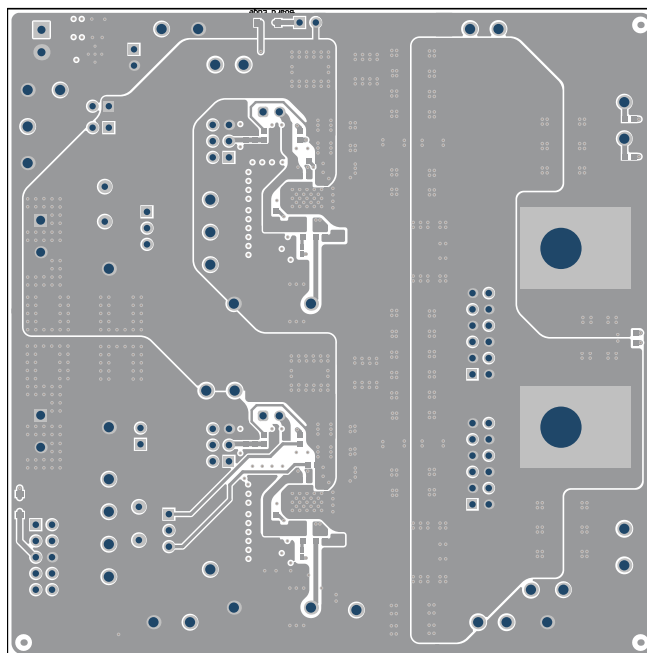
**Figure 28. TPS546D24AEVM-2PH Internal Layer 4 (Top View)**



**Figure 29. TPS546D24AEVM-2PH Internal Layer 5 (Top View)**



**Figure 30. TPS546D24AEVM-2PH Internal Layer 6 (Top View)**



**Figure 31. TPS546D24AEVM-2PH Internal Bottom Layer (Top View)**

## 9 Bill of Materials

Table 10 lists the BOM for the TPS546D24AEVM-2PH.

**Table 10. TPS546D24AEVM-2PH Bill of Materials<sup>(1)</sup>**

| Designator                                                                                                                       | Quantity | Value  | Description                                                          | Package                                      | Part Number         | Manufacturer                |
|----------------------------------------------------------------------------------------------------------------------------------|----------|--------|----------------------------------------------------------------------|----------------------------------------------|---------------------|-----------------------------|
| !PCB1                                                                                                                            | 1        |        | Printed Circuit Board                                                |                                              | BSR104              | Any                         |
| C1_P1, C1_P2, C11_P1, C11_P2                                                                                                     | 4        | 1uF    | CAP, CERM, 1 uF, 25 V, +/- 10%, X7R, 0603                            | 0603                                         | C0603C105K3RACTU    | Kemet                       |
| C2_P1, C2_P2, C33, C34                                                                                                           | 4        | 100uF  | CAP, AL, 100 uF, 35 V, +/- 20%, 0.15 ohm, SMD                        | SMT Radial G                                 | EEE-FC1V101P        | Panasonic                   |
| C3_P1, C3_P2, C4_P1, C4_P2, C5_P1, C5_P2, C6_P1, C6_P2                                                                           | 8        | 22uF   | CAP, CERM, 22 uF, 25 V, +/- 10%, X6S, 1210                           | 1210                                         | GRM32EC81E226KE15L  | MuRata                      |
| C7_P1, C7_P2, C8_P1, C8_P2, C9_P1, C9_P2                                                                                         | 6        | 6800pF | CAP, CERM, 6800 pF, 50 V, +/- 10%, X7R, 0402                         | 0402                                         | GRM155R71H682KA88D  | MuRata                      |
| C12_P1, C12_P2                                                                                                                   | 2        | 1000pF | CAP, CERM, 1000 pF, 100 V, +/- 5%, X7R, 0603                         | 0603                                         | 06031C102JAT2A      | AVX                         |
| C13_P1, C13_P2, C20_P1, C20_P2                                                                                                   | 4        | 0.1uF  | CAP, CERM, 0.1 uF, 50 V, +/- 10%, X7R, 0603                          | 0603                                         | C0603C104K5RACTU    | Kemet                       |
| C15_P1, C15_P2                                                                                                                   | 2        | 4.7uF  | CAP, CERM, 4.7 uF, 10 V, +/- 10%, X5R, 0603                          | 0603                                         | C0603C475K8PACTU    | Kemet                       |
| C17_P1                                                                                                                           | 1        | 100pF  | CAP, CERM, 100 pF, 50 V, +/- 5%, C0G/NP0, 0603                       | 0603                                         | GRM1885C1H101JA01D  | MuRata                      |
| C19_P1, C19_P2                                                                                                                   | 2        | 2.2uF  | CAP, CERM, 2.2 uF, 16 V, +/- 10%, X7R, 0603                          | 0603                                         | EMK107BB7225KA-T    | Taiyo Yuden                 |
| C21_P1, C21_P2                                                                                                                   | 2        | 33pF   | CAP, CERM, 33 pF, 50 V, +/- 5%, C0G/NP0, 0603                        | 0603                                         | C0603C330J5GACTU    | Kemet                       |
| C22                                                                                                                              | 1        | 1uF    | CAP, CERM, 1 uF, 50 V, +/- 10%, X7R, 0805                            | 0805                                         | C0805C105K5RACTU    | Kemet                       |
| C23                                                                                                                              | 1        | 10uF   | CAP, CERM, 10 uF, 10 V, +/- 20%, X7R, 0805                           | 0805                                         | C2012X7R1A106M125AC | TDK                         |
| C24                                                                                                                              | 1        | 0.01uF | CAP, CERM, 0.01 uF, 100 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0603      | 0603                                         | GCM188R72A103KA37J  | MuRata                      |
| C25, C26, C31, C32, C35, C36, C37, C38, C41, C42, C43, C44, C49, C50, C51, C52, C53, C54, C55, C56, C57, C58, C59, C60, C67, C68 | 26       | 47uF   | CAP, CERM, 47 uF, 10 V, +/- 10%, X7R, 1210                           | 1210                                         | GRM32ER71A476KE15L  | MuRata                      |
| C47, C48, C63, C64                                                                                                               | 4        | 470uF  | CAP, Tantalum Polymer, 470 uF, 6.3 V, +/- 20%, 0.01 ohm, 7343-40 SMD | 7343-40                                      | 6TPF470MAH          | Panasonic                   |
| D1, D2                                                                                                                           | 2        | 30V    | Diode, Schottky, 30 V, 2 A, AEC-Q101, SOD-123FL                      | SOD-123FL                                    | MBR230LSFT1G        | ON Semiconductor            |
| D1_P1, D1_P2                                                                                                                     | 2        | 45V    | Diode, Schottky, 45 V, 0.75 A, SOD-523                               | SOD-523                                      | BAS 52-02V H6327    | Infineon Technologies       |
| H1, H2                                                                                                                           | 2        |        | Machine Screw Pan Philips 10-32                                      |                                              | PMSSS 102 0050 PH   | B&F Fastener Supply         |
| H3, H4, H5, H6                                                                                                                   | 4        |        | Bumpon, Hemisphere, 0.44 X 0.20, Clear                               | Transparent Bumpon                           | SJ-5303 (CLEAR)     | 3M                          |
| H7, H8                                                                                                                           | 2        |        | Machine Screw Nut, Hex, 3/8", Stn, Steel, 10-32                      |                                              | HNSS 102            | B&F Fastener Supply         |
| H9, H10                                                                                                                          | 2        |        | Washer, Split Lock, #10                                              |                                              | 1477                | Keystone                    |
| J2                                                                                                                               | 1        |        | Header (shrouded), 100mil, 5x2, Gold, TH                             | 5x2 Shrouded header                          | 5103308-1           | TE Connectivity             |
| J4                                                                                                                               | 1        |        | Connector, Receptacle, Micro-USB Type B, R/A, Bottom Mount SMT       | MICRO USB CONN, R/A                          | 1981568-1           | TE Connectivity             |
| JP1_P1, JP1_P2                                                                                                                   | 2        |        | Header, 2.54 mm, 2x1, Gold, TH                                       | Header, 2.54mm, 2x1, TH                      | 61300211121         | Würth Elektronik            |
| JP2_P1, JP2_P2                                                                                                                   | 2        |        | Header, 100mil, 3x2, Gold, TH                                        | Sullins 100mil, 2x3, 230 mil above insulator | PBC03DAAN           | Sullins Connector Solutions |
| JP3, JP4, JP5                                                                                                                    | 3        |        | Header, 100mil, 2x1, Tin, TH                                         | Header, 2x1, 100mil, TH                      | 5-146278-2          | TE Connectivity             |

<sup>(1)</sup> Unless otherwise noted, all parts may be substituted with equivalents.

**Table 10. TPS546D24AEVM-2PH Bill of Materials<sup>(1)</sup> (continued)**

| Designator                                                                                                                                     | Quantity | Value | Description                                                                      | Package                              | Part Number      | Manufacturer                |
|------------------------------------------------------------------------------------------------------------------------------------------------|----------|-------|----------------------------------------------------------------------------------|--------------------------------------|------------------|-----------------------------|
| JP7_P1, JP7_P2                                                                                                                                 | 2        |       | Header, 100mil, 3x1, Gold, TH                                                    | PBC03SAAN                            | PBC03SAAN        | Sullins Connector Solutions |
| L1, L2                                                                                                                                         | 2        | 150nH | Inductor, Shielded, Ferrite, 150 nH, 55 A, 0.00015 ohm, SMD                      | SMD 13.46x8.0x12.95mm                | SLC1480-151MLB   | Coilcraft                   |
| LBL1                                                                                                                                           | 1        |       | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll         | PCB Label 0.650 x 0.200 inch         | THT-14-423-10    | Brady                       |
| LED1                                                                                                                                           | 1        | Green | LED, Green, SMD                                                                  | LED_0603                             | 150060GS75000    | Würth Elektronik            |
| R2_P1, R2_P2, R3_P1, R3_P2                                                                                                                     | 4        | 10    | RES, 10, 5%, 0.1 W, AEC-Q200 Grade 0, 0603                                       | 0603                                 | CRCW060310R0JNEA | Vishay-Dale                 |
| R4_P1, R4_P2, R15_P1, R15_P2, R16_P1, R16_P2, R17_P1, R17_P2, R18_P2, R22_P1, R22_P2, R23_P1, R23_P2, R25_P1, R25_P2, R27_P1, R27_P2, R32, R33 | 19       | 0     | RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0603                                        | 0603                                 | ERJ-3GEY0R00V    | Panasonic                   |
| R5_P1, R5_P2, R34, R35, R36, R38                                                                                                               | 6        | 49.9  | RES, 49.9, 1%, 0.1 W, AEC-Q200 Grade 0, 0603                                     | 0603                                 | CRCW060349R9FKEA | Vishay-Dale                 |
| R6_P1, R6_P2                                                                                                                                   | 2        | 1.0   | RES, 1.0, 5%, 0.25 W, AEC-Q200 Grade 0, 1206                                     | 1206                                 | CRCW12061R00JNEA | Vishay-Dale                 |
| R8_P2, R26_P1, R26_P2                                                                                                                          | 3        | 10.0k | RES, 10.0 k, 1%, 0.1 W, 0603                                                     | 0603                                 | RC0603FR-0710KL  | Yageo                       |
| R9_P1, R9_P2                                                                                                                                   | 2        | 30.1k | RES, 30.1 k, 1%, 0.1 W, 0603                                                     | 0603                                 | RC0603FR-0730K1L | Yageo                       |
| R14_P1, R14_P2                                                                                                                                 | 2        | 7.50k | RES, 7.50 k, 1%, 0.1 W, 0603                                                     | 0603                                 | ERJ-3EKF7501V    | Panasonic                   |
| R19_P1                                                                                                                                         | 1        | 14.7k | RES, 14.7 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603                                   | 0603                                 | ERJ-3EKF1472V    | Panasonic                   |
| R21_P1                                                                                                                                         | 1        | 12.1k | RES, 12.1 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603                                   | 0603                                 | CRCW060312K1FKEA | Vishay-Dale                 |
| R28                                                                                                                                            | 1        | 1.00k | RES, 1.00 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603                                   | 0603                                 | CRCW06031K00FKEA | Vishay-Dale                 |
| R29                                                                                                                                            | 1        | 47.5k | RES, 47.5 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603                                   | 0603                                 | CRCW060347K5FKEA | Vishay-Dale                 |
| R30                                                                                                                                            | 1        | 15.0k | RES, 15.0 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603                                   | 0603                                 | CRCW060315K0FKEA | Vishay-Dale                 |
| R31                                                                                                                                            | 1        | 560k  | RES, 560 k, 1%, 0.1 W, 0603                                                      | 0603                                 | RC0603FR-07560KL | Yageo                       |
| SH-JP1, SH-JP2, SH-JP3, SH-JP4, SH-JP5, SH-JP6                                                                                                 | 6        | 1x2   | Shunt, 100mil, Gold plated, Black                                                | Shunt                                | SNT-100-BK-G     | Samtec                      |
| SMB1_P1, SMB1_P2, SMB2                                                                                                                         | 3        |       | Connector, Receptacle, 50 ohm, TH                                                | SMB Connector                        | SMBR004D00       | JAE Electronics             |
| T1, T2                                                                                                                                         | 2        |       | Thermal Block, 5 mm, 2-pole, Tin, TH                                             | TH, 2-Leads, Body 10x10mm, Pitch 5mm | 282856-2         | TE Connectivity             |
| T3, T5                                                                                                                                         | 2        |       | Terminal 90A Lug                                                                 | CB70-14-CY                           | CB70-14-CY       | Panduit                     |
| T4                                                                                                                                             | 1        |       | Terminal Block, 3.5mm Pitch, 2x1, TH                                             | 7.0x8.2x6.5mm                        | ED555/2DS        | On-Shore Technology         |
| TP1_P1, TP1_P2, TP6, TP12, TP13, TP19, TP22, TP26                                                                                              | 8        |       | Test Point, Multipurpose, Red, TH                                                | Red Multipurpose Testpoint           | 5010             | Keystone                    |
| TP2_P1, TP2_P2, TP5_P1, TP5_P2, TP7, TP8, TP9, TP10, TP14, TP17, TP18, TP21, TP27, TP28, TP29, TP31                                            | 16       |       | Test Point, Multipurpose, White, TH                                              | White Multipurpose Testpoint         | 5012             | Keystone                    |
| TP3_P1, TP3_P2, TP4_P1, TP4_P2, TP11, TP15, TP16, TP20, TP23, TP24, TP25, TP30, TP32                                                           | 13       |       | Test Point, Multipurpose, Black, TH                                              | Black Multipurpose Testpoint         | 5011             | Keystone                    |
| U1_P1, U1_P2                                                                                                                                   | 2        |       | 2.95-16V 40A PMBUS Stackable Synchronous Buck Converter, RVF0040A (LQFN-CLIP-40) | RVF0040A                             | TPS546D24ARVFR   | Texas Instruments           |

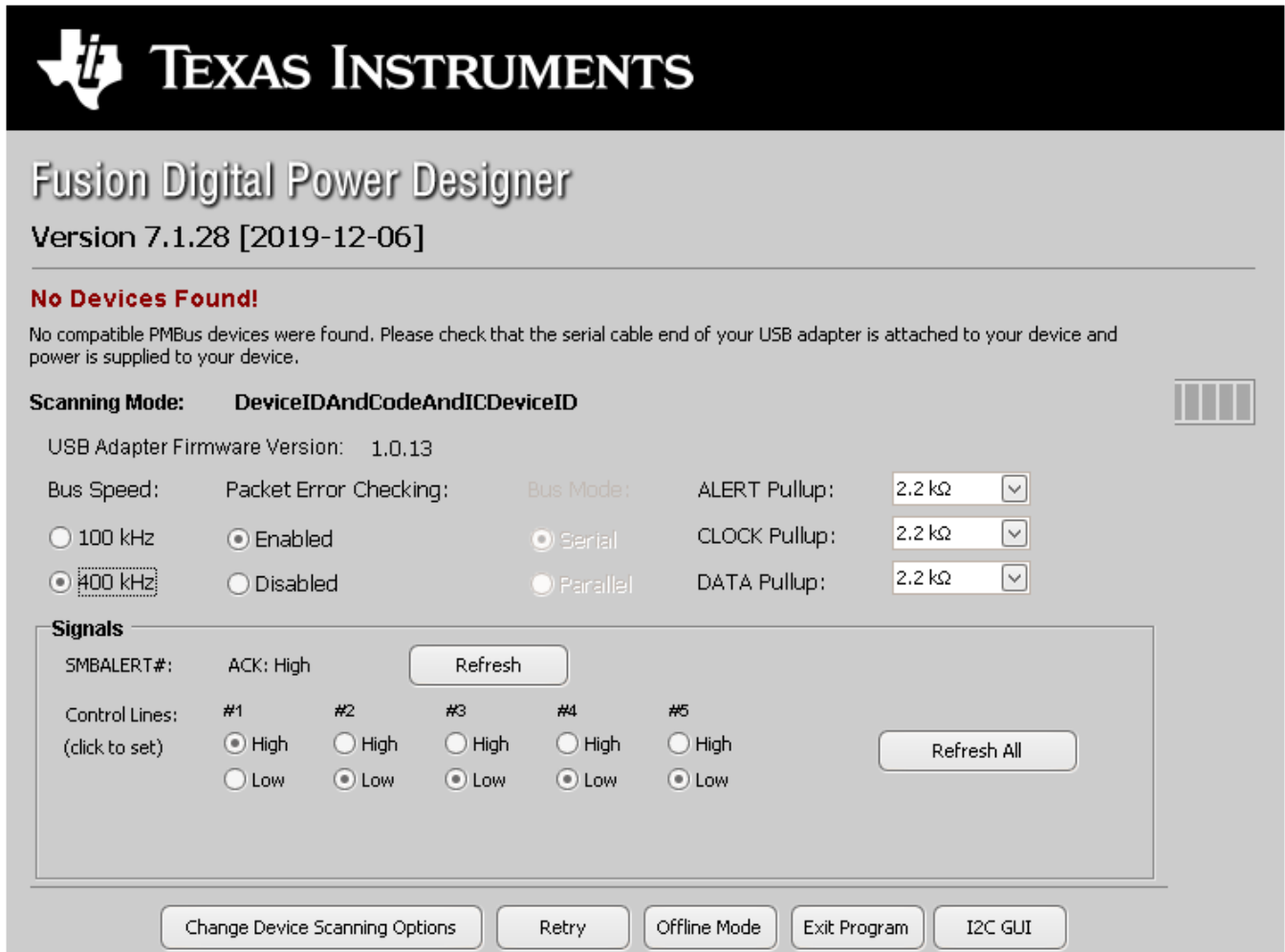
**Table 10. TPS546D24AEVM-2PH Bill of Materials<sup>(1)</sup> (continued)**

| Designator                                                                     | Quantity | Value | Description                                               | Package                     | Part Number        | Manufacturer      |
|--------------------------------------------------------------------------------|----------|-------|-----------------------------------------------------------|-----------------------------|--------------------|-------------------|
| U2                                                                             | 1        |       | 800-mA Ultra-Low-Noise, High-PSRR LDO, DNT0012B (WS0N-12) | DNT0012B                    | LP38798SD-ADJ/NOPB | Texas Instruments |
| C10_P1, C10_P2, C14_P1, C14_P2                                                 | 0        | 1uF   | CAP, CERM, 1 uF, 25 V, +/- 10%, X7R, 0603                 | 0603                        | C0603C105K3RACTU   | Kemet             |
| C16_P1, C16_P2                                                                 | 0        | 0.1uF | CAP, CERM, 0.1 uF, 50 V, +/- 10%, X7R, 0603               | 0603                        | C0603C104K5RACTU   | Kemet             |
| C17_P2                                                                         | 0        | 100pF | CAP, CERM, 100 pF, 50 V, +/- 5%, C0G/NP0, 0603            | 0603                        | GRM1885C1H101JA01D | MuRata            |
| C18_P1, C18_P2                                                                 | 0        | 2.2uF | CAP, CERM, 2.2 uF, 16 V, +/- 10%, X7R, 0603               | 0603                        | EMK107BB7225KA-T   | Taiyo Yuden       |
| C27, C28, C29, C30, C39, C40, C45, C46, C61, C62, C65, C66, C69, C70, C71, C72 | 0        | 47uF  | CAP, CERM, 47 uF, 10 V, +/- 10%, X7R, 1210                | 1210                        | GRM32ER71A476KE15L | MuRata            |
| FID1, FID2, FID3, FID4, FID5, FID6                                             | 0        |       | Fiducial mark. There is nothing to buy or mount.          | N/A                         | N/A                | N/A               |
| J1, J3                                                                         | 0        |       | Receptacle, 2.54mm, 6x2, Gold, TH                         | Receptacle, 2.54mm, 6x2, TH | SSQ-106-03-G-D     | Samtec            |
| JP6, JP8                                                                       | 0        |       | Header, 100mil, 2x1, Tin, TH                              | Header, 2x1, 100mil, TH     | 5-146278-2         | TE Connectivity   |
| R1_P1, R1_P2, R18_P1, R24_P1, R24_P2, R37, R39                                 | 0        | 0     | RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0603                 | 0603                        | ERJ-3GEY0R00V      | Panasonic         |
| R8_P1                                                                          | 0        | 10.0k | RES, 10.0 k, 1%, 0.1 W, 0603                              | 0603                        | RC0603FR-0710KL    | Yageo             |
| R10_P1, R10_P2, R11_P1, R11_P2, R12_P1, R12_P2, R20_P1, R20_P2                 | 0        | 10.5k | RES, 10.5 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603            | 0603                        | CRCW060310K5FKEA   | Vishay-Dale       |
| R13_P1, R13_P2                                                                 | 0        | 53.6k | RES, 53.6 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603            | 0603                        | CRCW060353K6FKEA   | Vishay-Dale       |
| R19_P2                                                                         | 0        | 14.7k | RES, 14.7 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603            | 0603                        | ERJ-3EKF1472V      | Panasonic         |
| R21_P2                                                                         | 0        | 12.1k | RES, 12.1 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603            | 0603                        | CRCW060312K1FKEA   | Vishay-Dale       |
| TP33                                                                           | 0        |       | Test Point, Multipurpose, Red, TH                         | Red Multipurpose Testpoint  | 5010               | Keystone          |
| TP34_P1, TP34_P2, TP35_P1, TP35_P2                                             | 0        |       | Test Point, Miniature, Red, TH                            | Red Miniature Testpoint     | 5000               | Keystone          |

## 10 Using the Fusion GUI

### 10.1 Opening the Fusion GUI

The Fusion GUI should include `IC_DEVICE_ID` in the scanning mode to find TPS546D24A. The EVM needs power to be recognized by the Fusion GUI. See [Section 5](#) for the recommended procedure.



**TEXAS INSTRUMENTS**

# Fusion Digital Power Designer

Version 7.1.28 [2019-12-06]

**No Devices Found!**

No compatible PMBus devices were found. Please check that the serial cable end of your USB adapter is attached to your device and power is supplied to your device.

**Scanning Mode:** DeviceIDAndCodeAndICDeviceID

USB Adapter Firmware Version: 1.0.13

Bus Speed: 100 kHz ☐ 400 kHz ☒

Packet Error Checking: Enabled ☒ Disabled ☐

Bus Mode: Serial ☒ Parallel ☐

ALERT Pullup: 2.2 kΩ

CLOCK Pullup: 2.2 kΩ

DATA Pullup: 2.2 kΩ

**Signals**

SMBALERT#: ACK: High

Control Lines: #1 #2 #3 #4 #5

(click to set) ☒ High ☐ High ☐ High ☐ High ☐ High

☐ Low ☒ Low ☒ Low ☒ Low ☒ Low

**Figure 32. Select Device Scanning Mode**

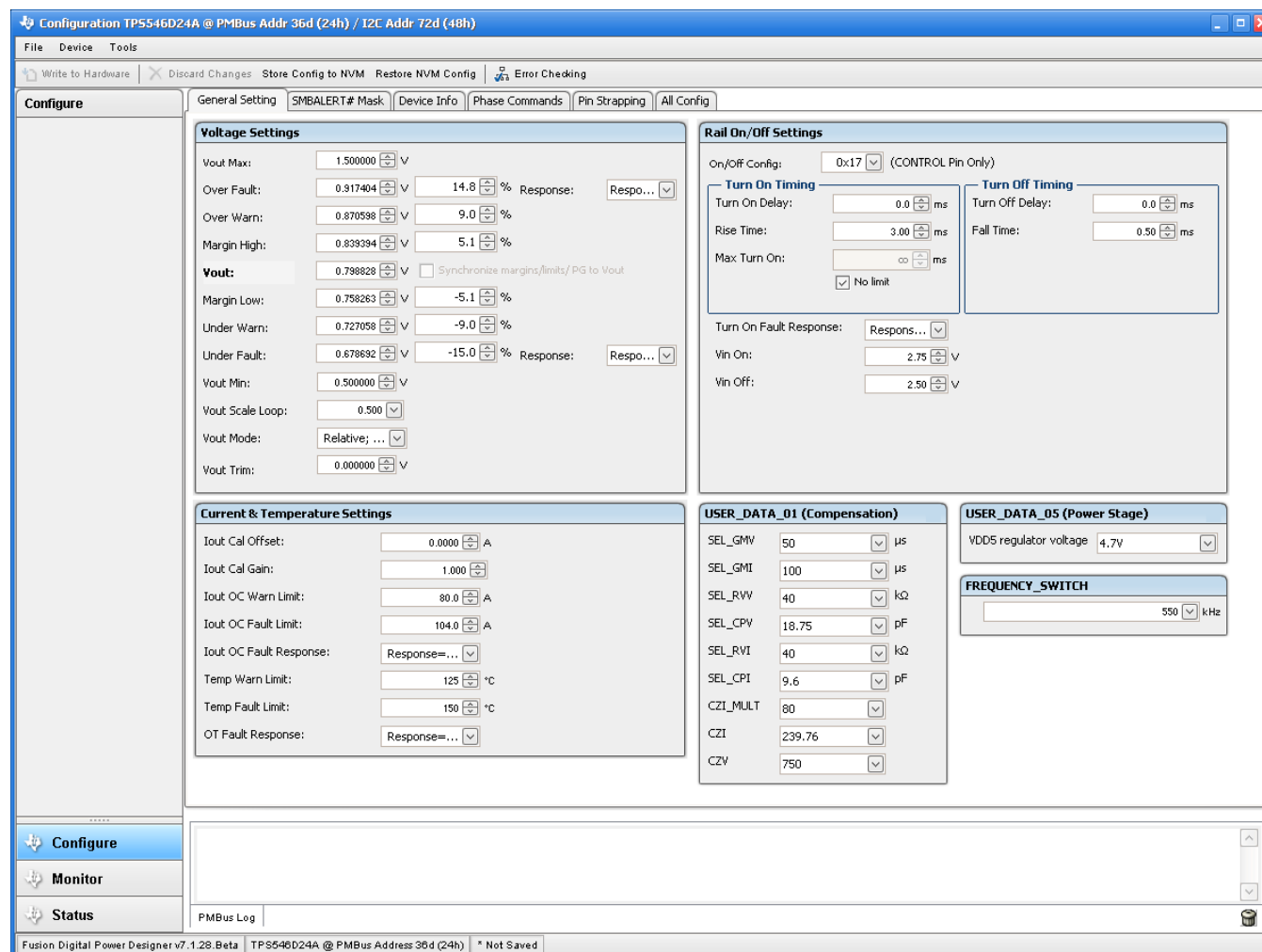
## 10.2 General Settings

Figure 33 shows the *General Settings* that can be used to configure the following:

- Vout settings, power good limits and margin voltages
- OC Fault, OC Warn and Fault response
- OT Fault, OT Warn (Die Temperature) and Fault response
- Vin on and off UVLO
- On/Off Config
- Soft Start (Output rise time), other Turn On Timing and Turn Off Timing
- Switching frequency
- Compensation

After clicking *Write to Hardware* to make changes to one or more configurable parameters, the changes can be committed to nonvolatile memory by clicking *Store Config to NVM*. This action prompts a pop-up, and if confirmed, the changes are committed to nonvolatile memory to store all the modifications in non-volatile memory.

Both the loop master device and the loop slave device are tied to same bus interface. In a two-phase stacking system, the master device will receive and respond to all PMBus communication and slave devices do not need to be connected to the PMBus. If the master receives commands which require updates to the PMBus registers of the slave, the master will relay these commands to the slaves. All commands on this tab are for PHASE = 0xFF.



**Configuration TPS546D24A @ PMBus Addr 36d (24h) / I2C Addr 72d (48h)**

File Device Tools

Write to Hardware Discard Changes Store Config to NVM Restore NVM Config Error Checking

**Configure** General Setting SMBALERT# Mask Device Info Phase Commands Pin Strapping All Config

**Voltage Settings**

Vout Max: 1.500000 V

Over Fault: 0.317404 V 14.8 % Response: Respo...

Over Warn: 0.870598 V 9.0 %

Margin High: 0.839394 V 5.1 %

Vout: 0.798828 V Synchronize margins/limits/ PG to Vout

Margin Low: 0.758263 V -5.1 %

Under Warn: 0.727058 V -9.0 %

Under Fault: 0.678632 V -15.0 % Response: Respo...

Vout Min: 0.500000 V

Vout Scale Loop: 0.500

Vout Mode: Relative; ...

Vout Trim: 0.000000 V

**Rail On/Off Settings**

On/Off Config: 0x17 (CONTROL Pin Only)

**Turn On Timing**

Turn On Delay: 0.0 ms

Rise Time: 3.00 ms

Max Turn On: ∞ ms

☒ No limit

**Turn Off Timing**

Turn Off Delay: 0.0 ms

Fall Time: 0.50 ms

Turn On Fault Response: Respons...

Vin On: 2.75 V

Vin Off: 2.50 V

**Current & Temperature Settings**

Iout Cal Offset: 0.0000 A

Iout Cal Gain: 1.000

Iout OC Warn Limit: 80.0 A

Iout OC Fault Limit: 104.0 A

Iout OC Fault Response: Response=...

Temp Warn Limit: 125 °C

Temp Fault Limit: 150 °C

OT Fault Response: Response=...

**USER\_DATA\_01 (Compensation)**

SEL\_GMV 50 μs

SEL\_GMI 100 μs

SEL\_RVV 40 kΩ

SEL\_CPV 18.75 pF

SEL\_RVI 40 kΩ

SEL\_CPI 9.6 pF

CZI\_MULT 80

CZI 239.76

CZV 750

**USER\_DATA\_05 (Power Stage)**

VDD5 regulator voltage 4.7V

**FREQUENCY\_SWITCH**

550 kHz

**Configure**

**Monitor**

**Status**

PMBus Log

Fusion Digital Power Designer v7.1.28 Beta TPS546D24A @ PMBus Address 36d (24h) \* Not Saved

Figure 33. General Settings

Some commands require the

### 10.3 Changing ON\_OFF\_CONFIG

Changing the *On/Off Config* prompts a pop-up window with details of the options shown in Figure 34. This pop-up gives multiple options on what turns on and off power conversion. By default the TPS546D24A is configured to *CONTROL Pin Only*. This is the EN/UVLO pin.

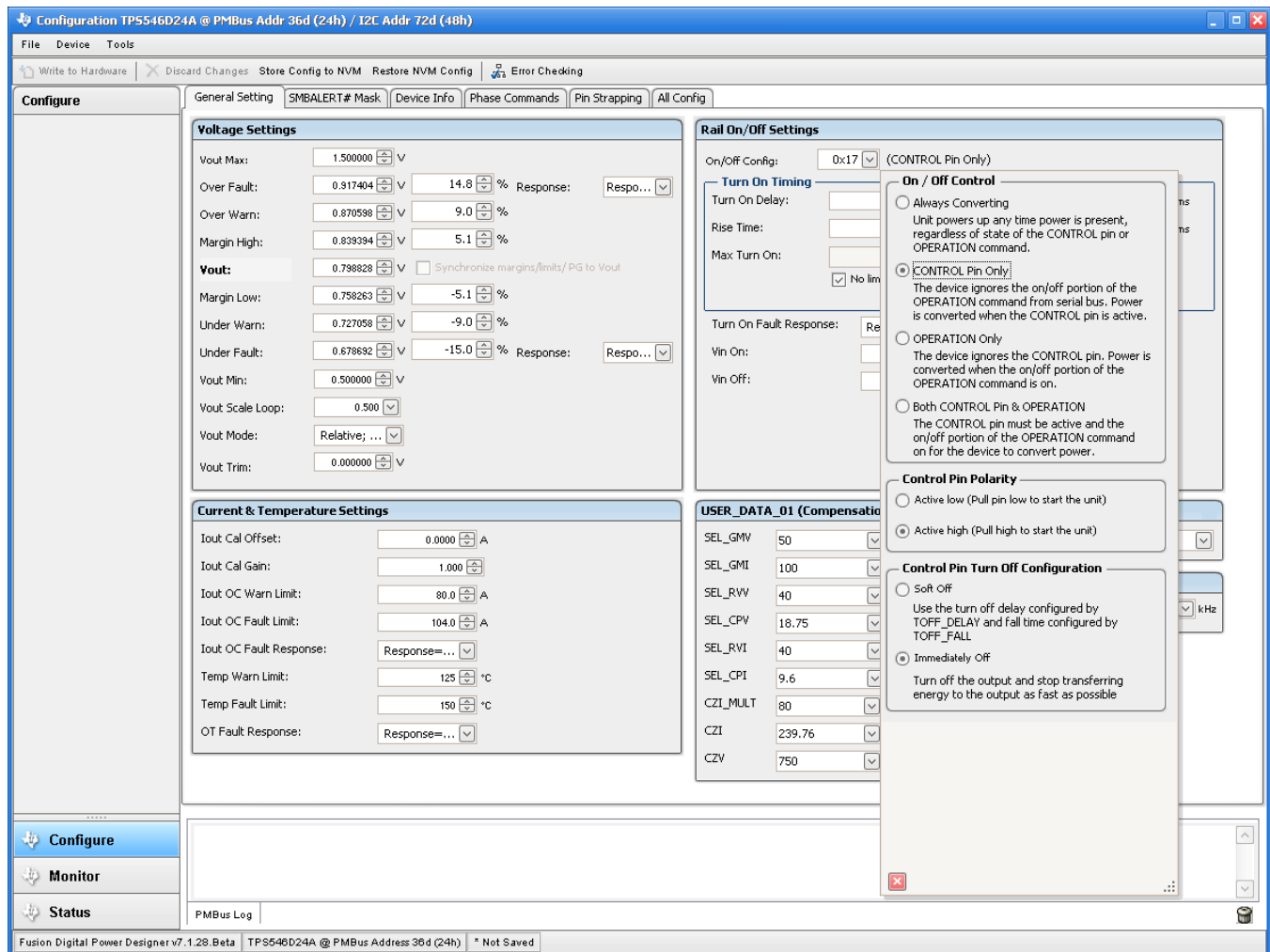
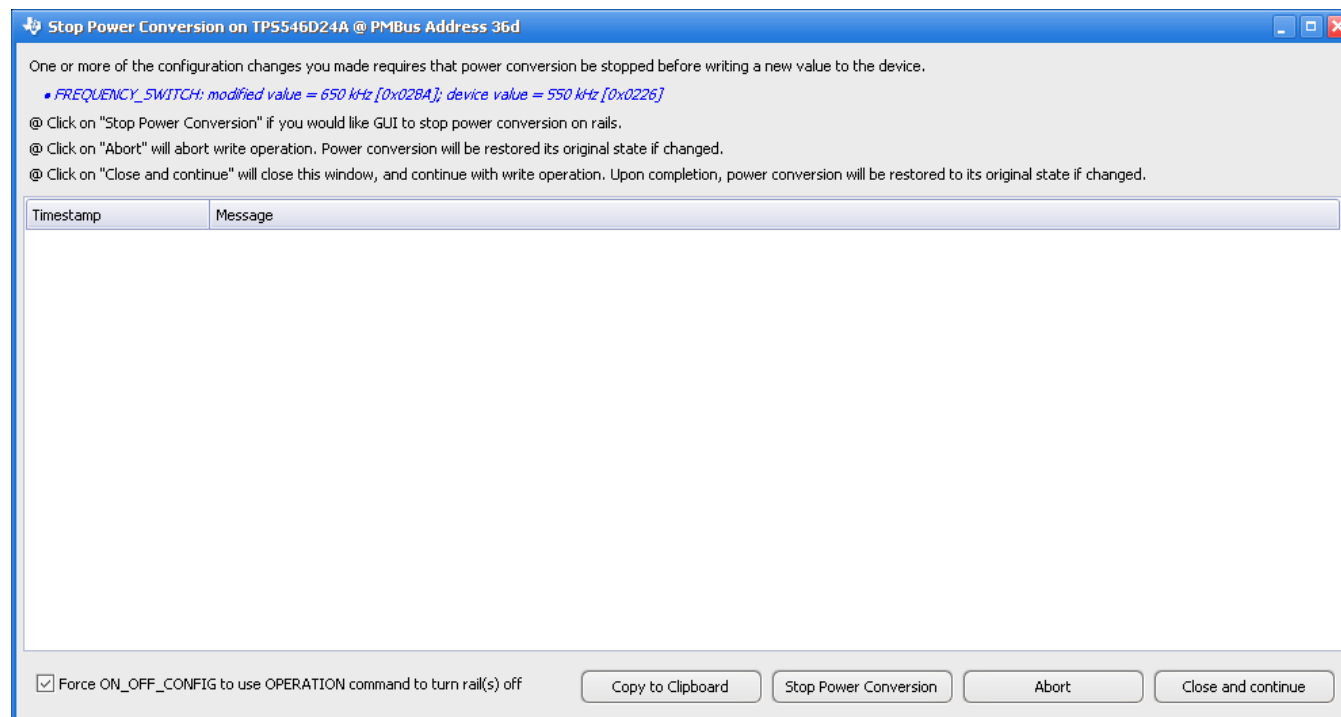


Figure 34. Configure – ON\_OFF\_CONFIG

## 10.4 Pop-up for Some Commands While Conversion is Enabled

Some commands will cause a pop-up like the one shown in [Figure 35](#) when trying to change them while conversion is enabled. The settings in the GUI which will cause this pop-up include *FREQUENCY\_SWITCH*, *USER\_DATA\_01 (Compensation)*, *Vout Mode* and *Vout Scale Loop*. To change these settings to a new value, click on *Stop Power Conversion* then *Close and continue*. The GUI will automatically disable conversion, write the new value, and enable conversion again.



**Figure 35. Pop-up When Trying to Change FREQUENCY\_SWITCH With Conversion Enabled**

## 10.5 SMBALERT# Mask

The sources of SMBALERT which can be masked are found and configured on the *SMBALERT # Mask* tab (Figure 36).

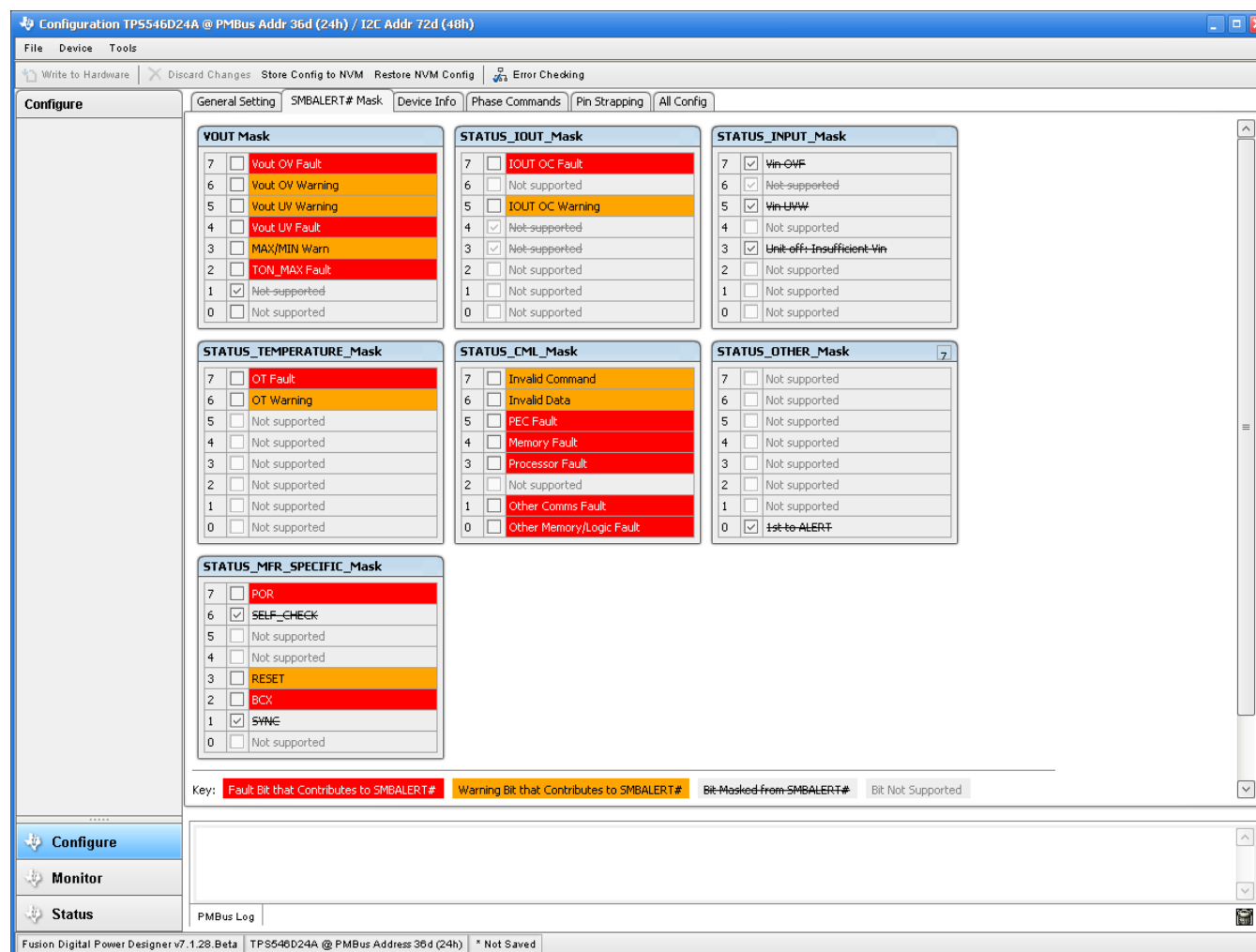
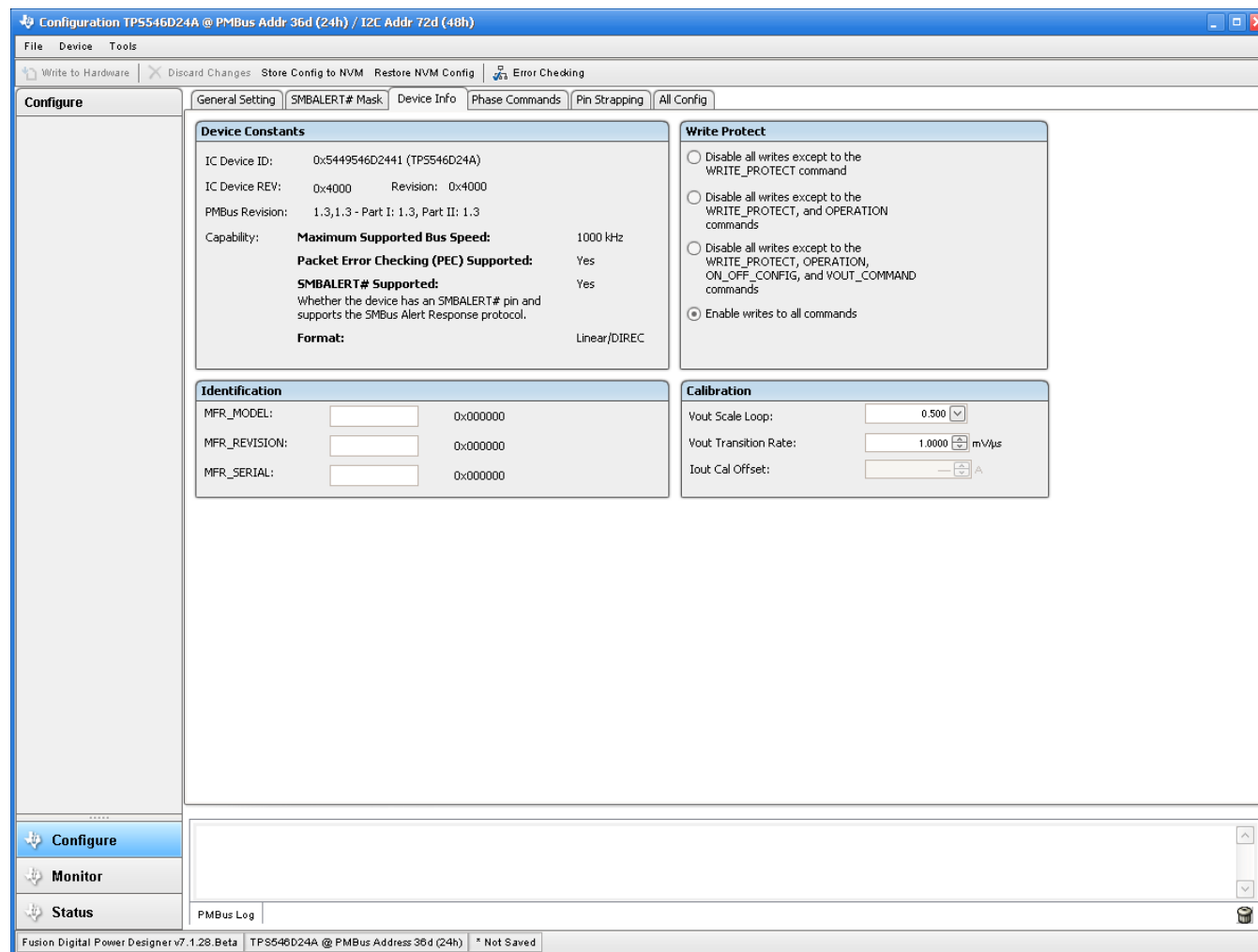


Figure 36. Configure – SMBALERT # Mask

## 10.6 Device Info

The device information, Write Protection options, the configuration of *Vout Scale Loop*, *Vout Transition Rate*, and *Iout Cal Offset* are found on the *Device Info* tab (see [Figure 37](#)).



**Figure 37. Configure – Device Info**

## 10.7 Phase Commands

Use the *Phase Command* tab (see [Figure 38](#)) to calibrate the *IOUT/Temp* of each phase.

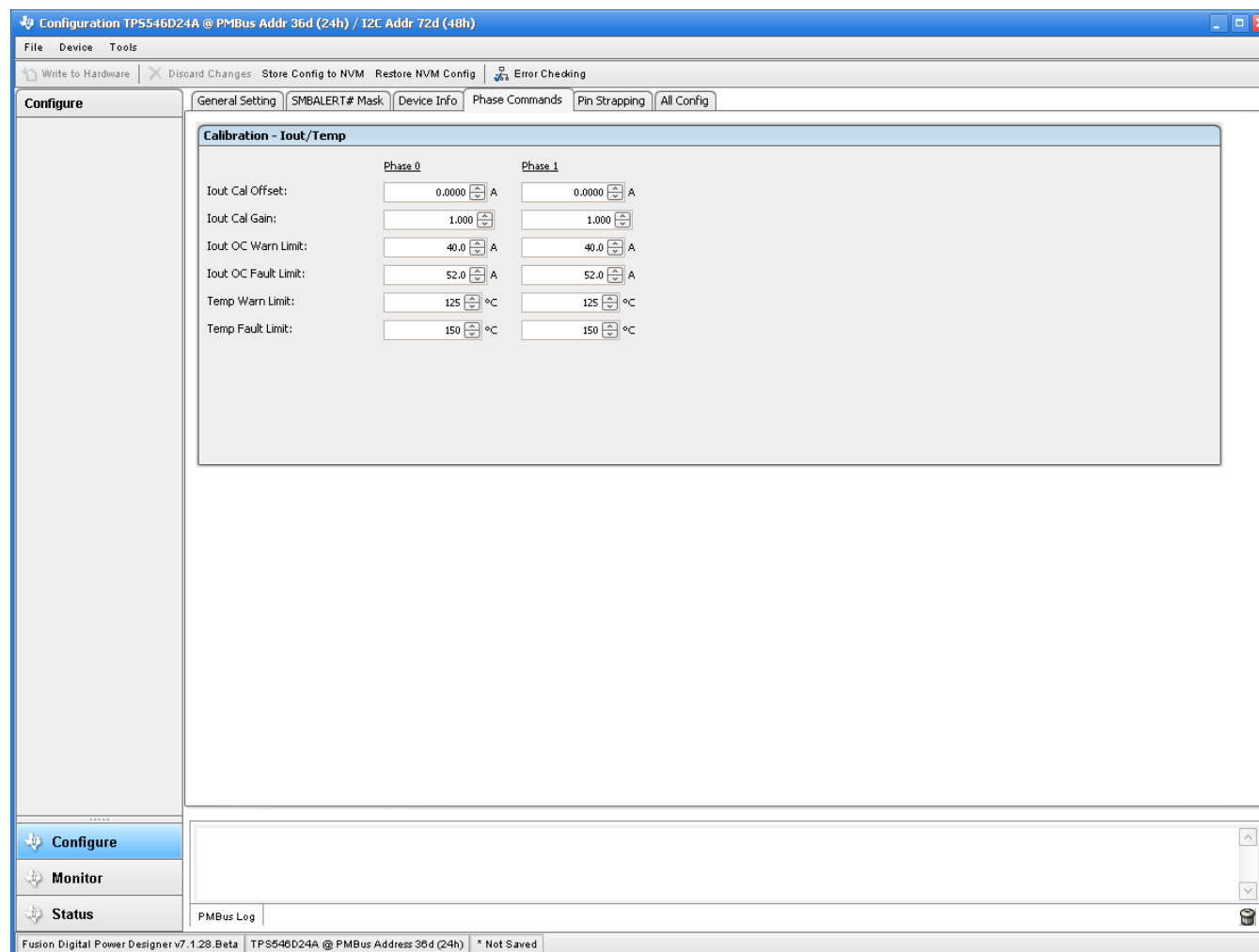


Figure 38. Phase Commands

## 10.8 All Config

Use the *All Config* tab (Figure 39) to configure all of the configurable parameters, which also shows other details like Hex encoding.

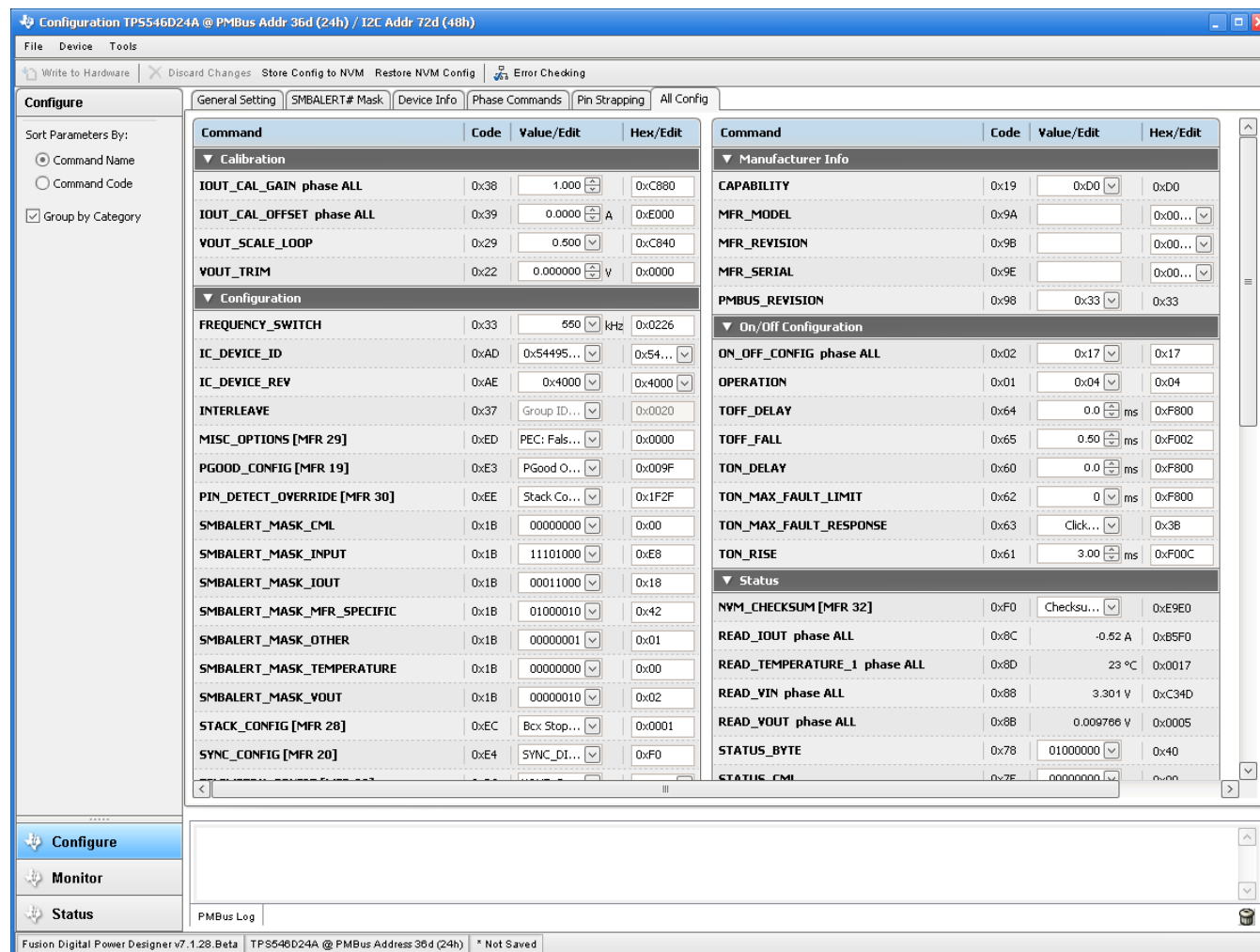
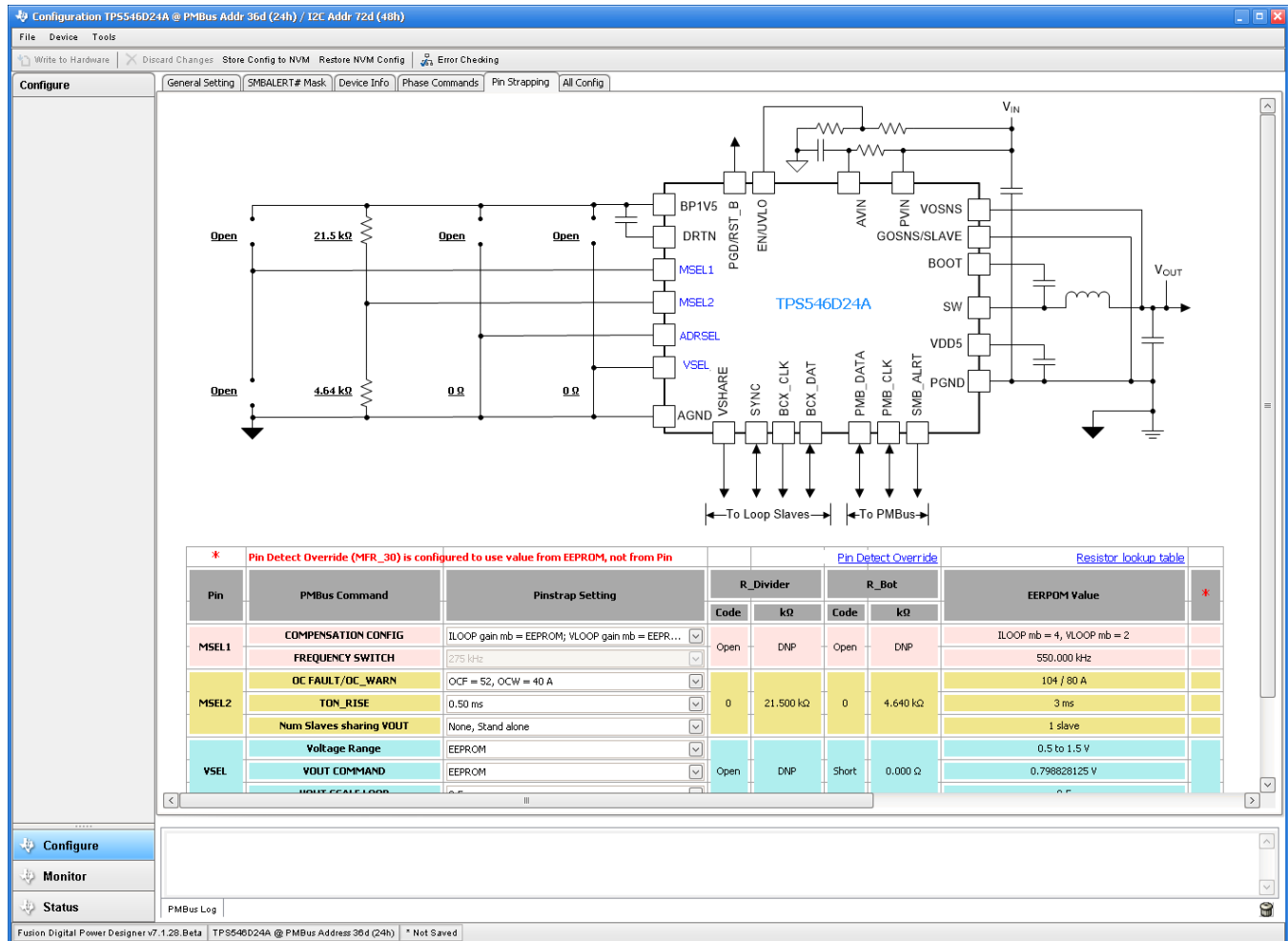


Figure 39. Configure – All Config

## 10.9 Pin Strapping

Use the *Pin Strapping* tab (Figure 39) to aid in selection of external pin strapping resistors used to program some of the PMBus commands at power-up. The *EEPROM Value* column shows the values currently configured to the related PMBus commands.



**Configuration TPS546D24A @ PMBus Addr 36d (24h) / I2C Addr 72d (40h)**

File Device Tools

Write to Hardware Discard Changes Store Config to NVM Restore NVM Config Error Checking

Configure General Setting SMBALERT# Mask Device Info Phase Commands Pin Strapping All Config

Pin Diagram Labels: BP1V5, DRTN, MSEL1, MSEL2, ADRSEL, VSEL, AGND, SYNC, BCX\_CLK, BCX\_DAT, PMB\_DATA, PMB\_CLK, SMB\_ALERT, PGND, VIN, AVIN, PVIN, VOSNS, GOSNS/SLAVE, BOOT, SW, VDD5, VOUT.

Resistor Values: 21.5 kΩ, 4.64 kΩ, 0 Ω.

Pin Detect Override (MFR\_30) is configured to use value from EEPROM, not from Pin

| Pin   | PMBus Command           | Pinstrap Setting                               | Pin Detect Override |           | EEPROM Value | *        |                            |
|-------|-------------------------|------------------------------------------------|---------------------|-----------|--------------|----------|----------------------------|
|       |                         |                                                | R_Divider           | R_Bot     |              |          |                            |
|       |                         |                                                | Code                | kΩ        | Code         | kΩ       |                            |
| MSEL1 | COMPENSATION CONFIG     | ILoop gain mb = EEPROM; VLoop gain mb = EEPROM | Open                | DNP       | Open         | DNP      | ILoop mb = 4, VLoop mb = 2 |
|       | FREQUENCY SWITCH        | 275 kHz                                        | Open                | DNP       | Open         | DNP      | 550.000 kHz                |
|       | OC_FAULT/OC_WARN        | OCF = 52, OCV = 40 A                           | 0                   | 21.500 kΩ | 0            | 4.640 kΩ | 104 / 80 A                 |
| MSEL2 | TON_RISE                | 0.50 ms                                        | 0                   | 21.500 kΩ | 0            | 4.640 kΩ | 3 ms                       |
|       | Num Slaves sharing VOUT | None, Stand alone                              | 0                   | 21.500 kΩ | 0            | 4.640 kΩ | 1 slave                    |
| VSEL  | Voltage Range           | EEPROM                                         | Open                | DNP       | Short        | 0.000 Ω  | 0.5 to 1.5 V               |
|       | VOUT COMMAND            | EEPROM                                         | Open                | DNP       | Short        | 0.000 Ω  | 0.798828125 V              |

Configure Monitor Status

PMBus Log

Fusion Digital Power Designer v7.1.28.Beta TPS546D24A @ PMBus Address 36d (24h) \* Not Saved

Figure 40. Configure – Pin Strapping

## 10.10 Monitor

When the *Monitor* screen (Figure 41) is selected, the screen changes to display real-time data of the parameters that are measured by the device. This screen provides access to:

- Graphs of *Vout*, *Iout*, *Vin*, *Pout*, and *Temperature*
- *Start and Stop Polling* which turns ON or OFF the realtime display of data
- Quick access to *On/Off Config*
- Control pin activation and *OPERATION* command
- Margin control
- Clear Fault: Selecting **Clear Faults** clears any prior fault flags.

With two devices stacked together, the *Iout* reading is the total load supported by both devices. There is also an *Iout* which shows the current in each phase.

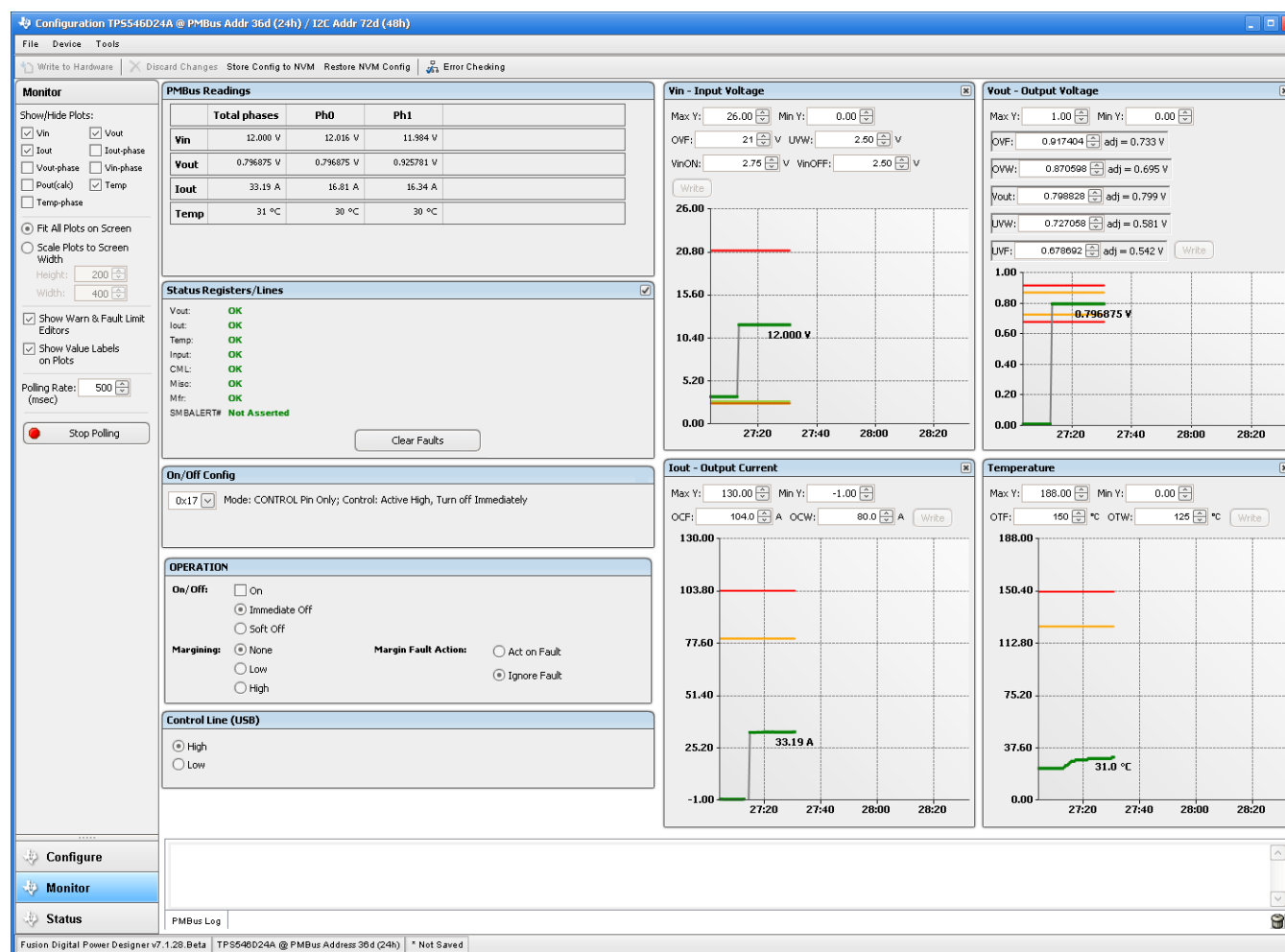


Figure 41. Monitor Screen

## 10.11 Status

Selecting *Status* screen from lower left corner (Figure 42) shows the status of the device.

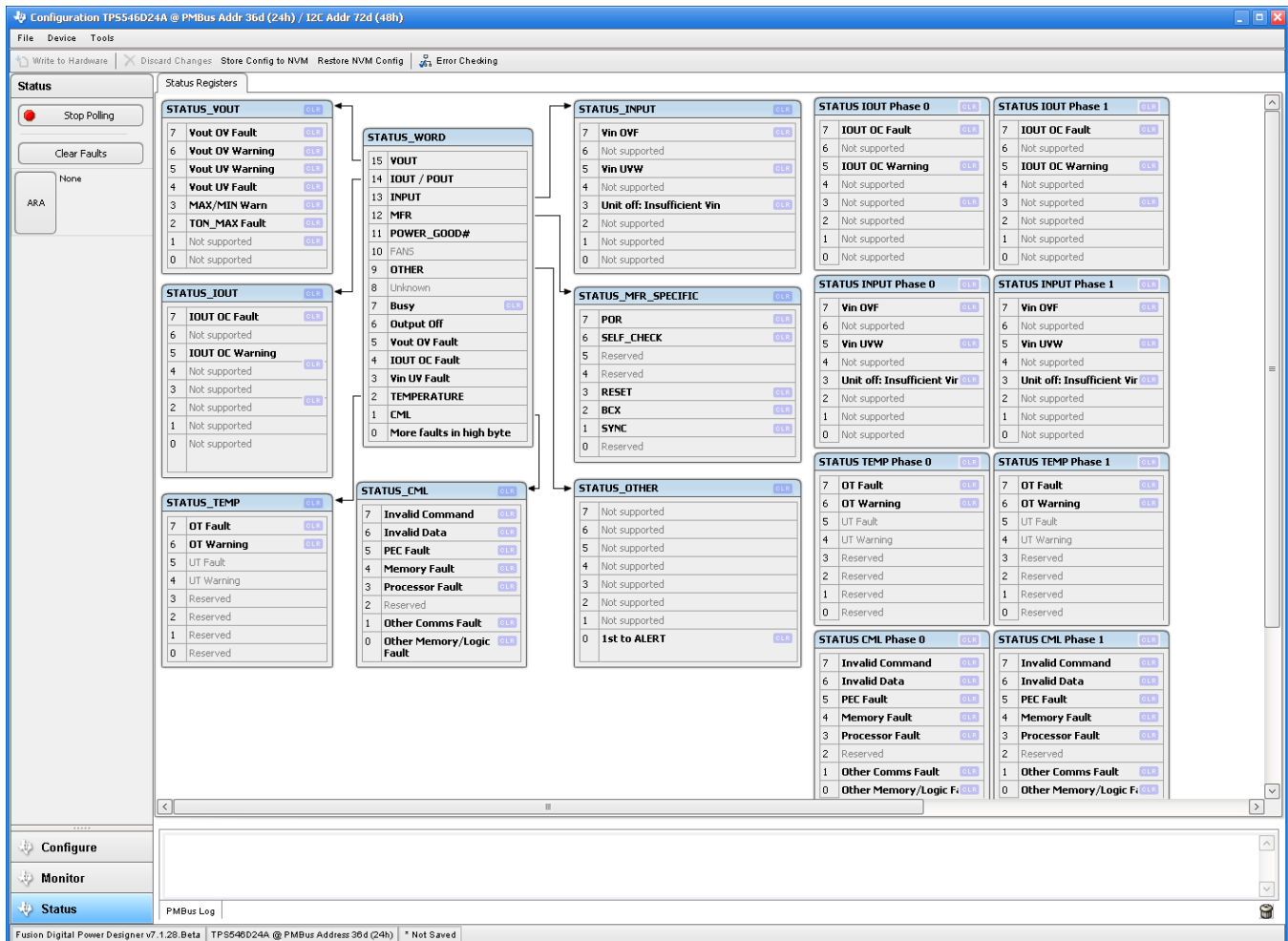


Figure 42. Status Screen

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